NICHIA CORPORATION

SPECIFICATIONS FOR RED LED

PART NO. NHSR146AT

- Pb-free Reflow Soldering Application
- ESD Withstand Voltage (HBM) Class 3B
- RoHS Compliant
- IATF 16949 Compliant

SPECIFICATIONS

(1) Absolute Maximum Ratings

Item	Symbol	Absolute Maximum Rating	Unit
Forward Current	I_F	15	mA
Pulse Forward Current	I_{FP}	30	mA
ESD Withstand Voltage (HBM)	V_{ESD}	8	kV
Allowable Reverse Current	I_R	85	mA
Power Dissipation	P_D	53	mW
Operating Temperature	T_{opr}	-40~110	°C
Storage Temperature	T_{stg}	-40~110	°C
Junction Temperature	T_J	125	°C

* Absolute Maximum Ratings at T_A=25°C.
* I_{FP} conditions with pulse width ≤10ms and duty cycle ≤10%.
* HBM ESD Component Classification Level of the LEDs: Class 3B
  For more details, see ANSI/ESDA/JEDEC JS-001.

(2) Initial Electrical/Optical Characteristics

Item			Symbol	Condition	Typ	Max	Unit
Forward Voltage			V_F	I_F=10mA	3.1	-	V
Or5z (Dominant Wavelength: 597~603nm)	Luminous Intensity		I_v	I_F=10mA	300	-	mcd
	Chromaticity Coordinate (Dominant Wavelength: 600nm)	x	-	I_F=10mA	0.616	-	-
		y		I_F=10mA	0.372	-	
Or6z (Dominant Wavelength: 600~606nm)	Luminous Intensity		I_v	I_F=10mA	240	-	mcd
	Chromaticity Coordinate (Dominant Wavelength: 603nm)	x	-	I_F=10mA	0.628	-	-
		y		I_F=10mA	0.359	-	
Or7z (Dominant Wavelength: 603~609nm)	Luminous Intensity		I_v	I_F=10mA	190	-	mcd
	Chromaticity Coordinate (Dominant Wavelength: 606nm)	x	-	I_F=10mA	0.640	-	-
		y		I_F=10mA	0.348	-	
R13z (Dominant Wavelength: 611~618nm)	Luminous Intensity		I_v	I_F=10mA	100	-	mcd
	Chromaticity Coordinate (Dominant Wavelength: 615nm)	x	-	I_F=10mA	0.677	-	-
		y		I_F=10mA	0.320	-	
R14z (Dominant Wavelength: 616~623nm)	Luminous Intensity		I_v	I_F=10mA	70	-	mcd
	Chromaticity Coordinate (Dominant Wavelength: 620nm)	x	-	I_F=10mA	0.688	-	-
		y		I_F=10mA	0.309	-	
R15z (Dominant Wavelength: 626~633nm)	Luminous Intensity		I_v	I_F=10mA	45	-	mcd
	Chromaticity Coordinate (Dominant Wavelength: 630nm)	x	-	I_F=10mA	0.704	-	-
		y		I_F=10mA	0.292	-	
R16z (Dominant Wavelength: 630~637nm)	Luminous Intensity		I_v	I_F=10mA	30	-	mcd
	Chromaticity Coordinate (Dominant Wavelength: 633nm)	x	-	I_F=10mA	0.708	-	-
		y		I_F=10mA	0.289	-	
Thermal Resistance			$R_{\theta JS_real}$	-	-	294	°C/W
			$R_{\theta JS_el}$	-	-	265	

* Characteristics at T_A=25°C.
* Luminous Intensity value as per CIE 127:2007 standard.
* Chromaticity Coordinates as per CIE 1931 Chromaticity Chart.
* Dominant Wavelength is for reference purpose.
* Thermal resistance values ($R_{\theta JS_real}$) determined by considering the energy conversion efficiency(η_e=10%). Refer to JESD51.

RANKS

Item	Rank	Min	Max	Unit
Forward Voltage	-	2.7	3.5	V
Luminous Intensity	Cd360	360	430	mcd
	Cd300	300	360	
	Cd250	250	300	
	Cd210	210	250	
	Cd180	180	210	
	Cd150	150	180	
	Cd105	105	125	
	Cd90	90	105	
	Cd75	75	90	
	Cd63	63	75	
	Cd53	53	63	
	Cd45	45	53	
	Cd38	38	45	
	Cd32	32	38	
	Cd27	27	32	
	Cd23	23	27	

Color Ranks

	Rank Or5z (Dominant Wavelength: 597~603nm)			
x	0.6183	0.5930	0.6130	0.6402
y	0.3580	0.3831	0.3865	0.3594

	Rank Or6z (Dominant Wavelength: 600~606nm)			
x	0.6294	0.6065	0.6271	0.6520
y	0.3469	0.3697	0.3725	0.3477

	Rank Or7z (Dominant Wavelength: 603~609nm)			
x	0.6392	0.6183	0.6402	0.6625
y	0.3372	0.3580	0.3594	0.3372

	Rank R13z (Dominant Wavelength: 611~618nm)			
x	0.6692	0.6518	0.6690	0.6873
y	0.3139	0.3312	0.3310	0.3126

	Rank R14z (Dominant Wavelength: 616~623nm)			
x	0.6787	0.6649	0.6825	0.6972
y	0.3044	0.3182	0.3174	0.3027

	Rank R15z (Dominant Wavelength: 626~633nm)			
x	0.6926	0.6836	0.7022	0.7117
y	0.2906	0.2996	0.2977	0.2883

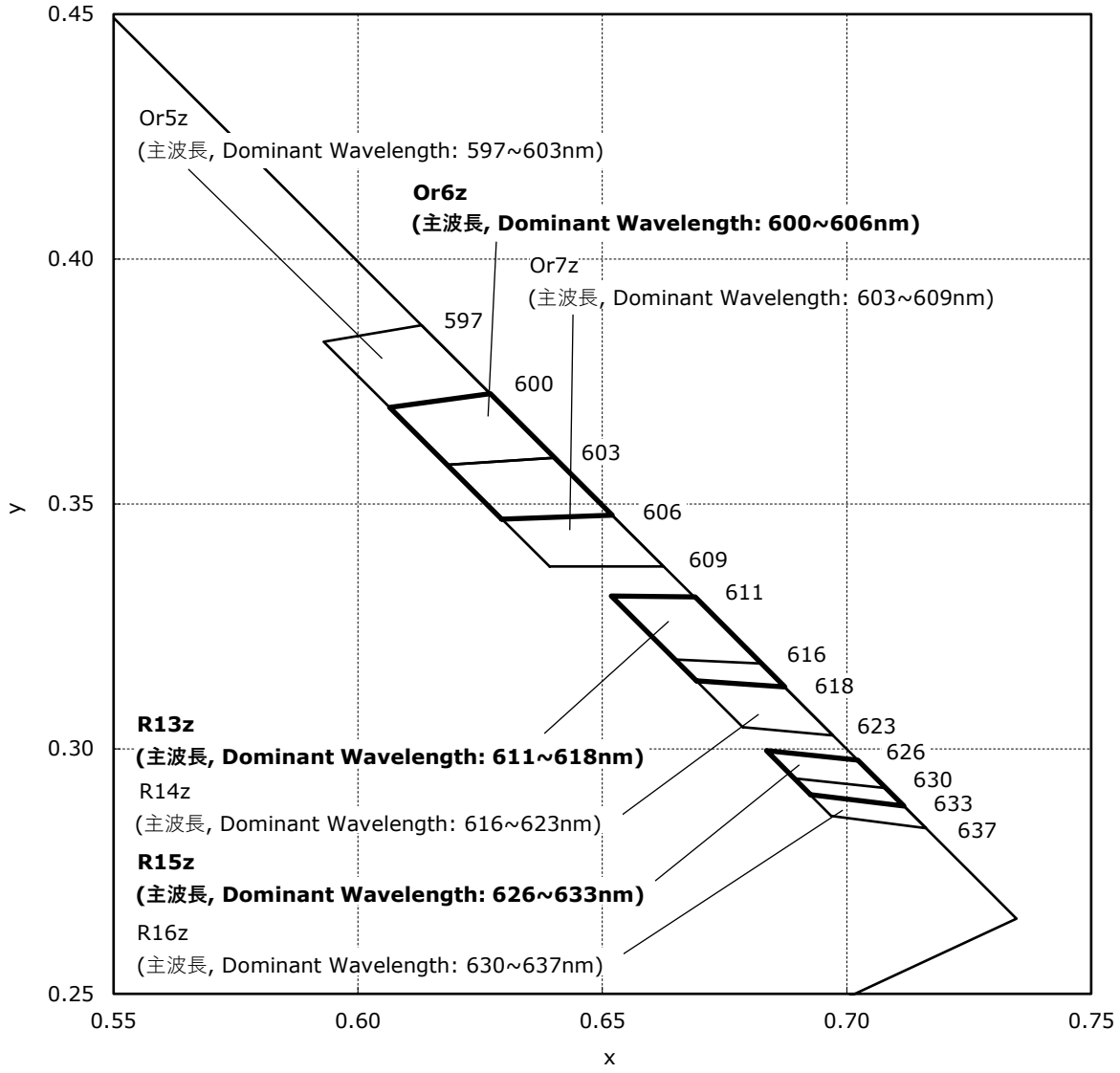
	Rank R16z (Dominant Wavelength: 630~637nm)			
x	0.6968	0.6891	0.7080	0.7162
y	0.2863	0.2940	0.2920	0.2838

* Ranking at T_A=25°C.
* Forward Voltage Tolerance: ±0.05V
* Luminous Intensity Tolerance: ±5%
* Chromaticity Coordinate Tolerance: ±0.003
* Dominant Wavelength is for reference purpose.
* LEDs from the above ranks will be shipped. The rank combination ratio per shipment will be decided by Nichia.

Luminous Intensity Ranks by Color Rank

Ranking by Luminous Intensity / Ranking by Color Coordinates	Cd23, Cd27	Cd32, Cd38	Cd45, Cd53	Cd63, Cd75	Cd90, Cd105	Cd150	Cd180, Cd210	Cd250	Cd300, Cd360
Or5z(Dominant Wavelength: 597~603nm)									
Or6z(Dominant Wavelength: 600~606nm)									
Or7z(Dominant Wavelength: 603~609nm)									
R13z(Dominant Wavelength: 611~618nm)									
R14z(Dominant Wavelength: 616~623nm)									
R15z(Dominant Wavelength: 626~633nm)									
R16z(Dominant Wavelength: 630~637nm)									

CHROMATICITY DIAGRAM

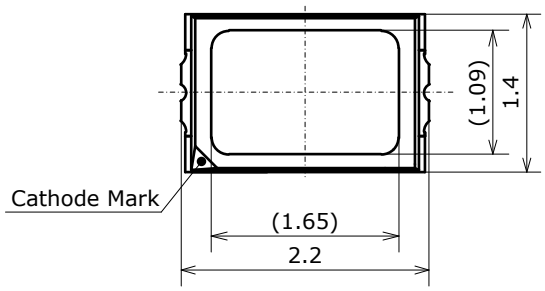


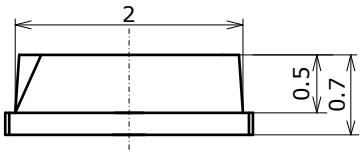
OUTLINE DIMENSIONS

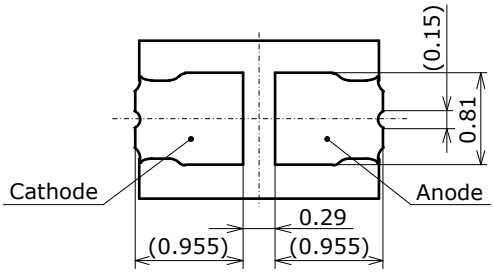
* 本製品はRoHS指令に適合しております。
  This product complies with RoHS Directive.
* 括弧で囲まれた寸法は参考値です。
  The dimension(s) in parentheses are for reference purposes.

NxSR146A
管理番号 No. STS-DA7-11645B

(単位 Unit: mm, 公差 Tolerance: ±0.1)

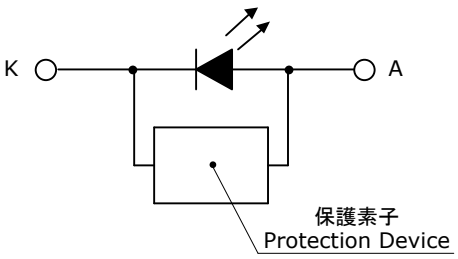






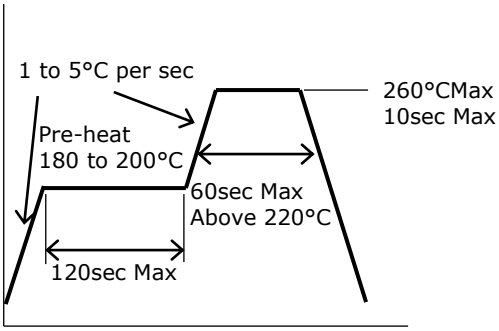
項目 Item	内容 Description
パッケージ材質 Package Materials	耐熱性ポリマー Heat-Resistant Polymer
封止樹脂材質 Encapsulating Resin Materials	シリコーン樹脂(蛍光体入り) Silicone Resin(with phosphor)
電極材質 Electrodes Materials	銅合金+金メッキ Au-plated Copper Alloy
質量 Weight	0.0052g(TYP)

＊バリは寸法に含まないものとします。
Dimensions do not include mold flash or metal burr.



SOLDERING

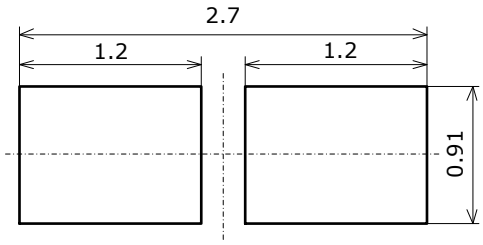
• Recommended Reflow Soldering Condition(Lead-free Solder)



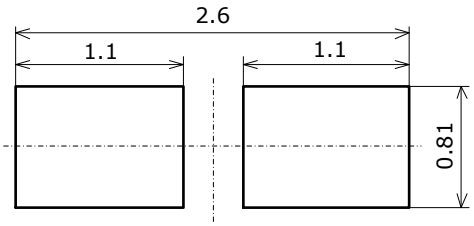
• Recommended Hand Soldering Condition

Temperature	350°C Max
Soldering Time	3sec Max

• Recommended Soldering Pad Pattern



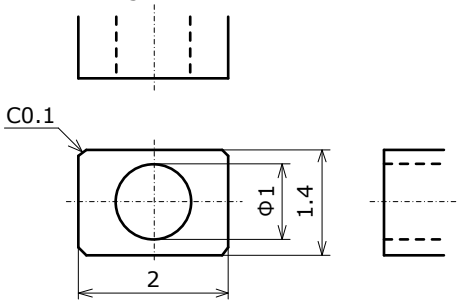
• Recommended Metal Solder Stencil Aperture



(単位 Unit: mm)

* This LED is designed to be reflow soldered to a PCB. If dip soldered, Nichia will not guarantee its reliability.
* Reflow soldering must not be performed more than twice. Hand soldering must not be performed more than once.
* When cooling the LEDs from the peak temperature a gradual cooling slope is recommended; do not cool the LEDs rapidly.
* During reflow soldering, the heat and atmosphere in the reflow oven may cause the optical characteristics to degrade. In particular, reflow soldering performed with an air atmosphere may have a greater negative effect on the optical characteristics than if a nitrogen atmosphere is used; Nichia recommends using a nitrogen reflow atmosphere.
* This LED uses a silicone resin for the encapsulating resin; the silicone resin is soft. If pressure is applied to the silicone resin, it may cause the resin to be damaged, chipped, delaminated and/or deformed. If the resin is damaged, chipped, delaminated and/or deformed, it may cause the wire to break causing a catastrophic failure (i.e. the LED not to illuminate) and/or reliability issues (e.g. the LED to corrode and/or to become dimmer, the color/directivity to change, etc.).

  Using a nozzle designed for the LEDs is recommended. (See Figure below)



(単位 Unit: mm)

Ensure that there are no issues with the mounting conditions (e.g. mounting pressure, vacuuming pressure, etc.) prior to use.

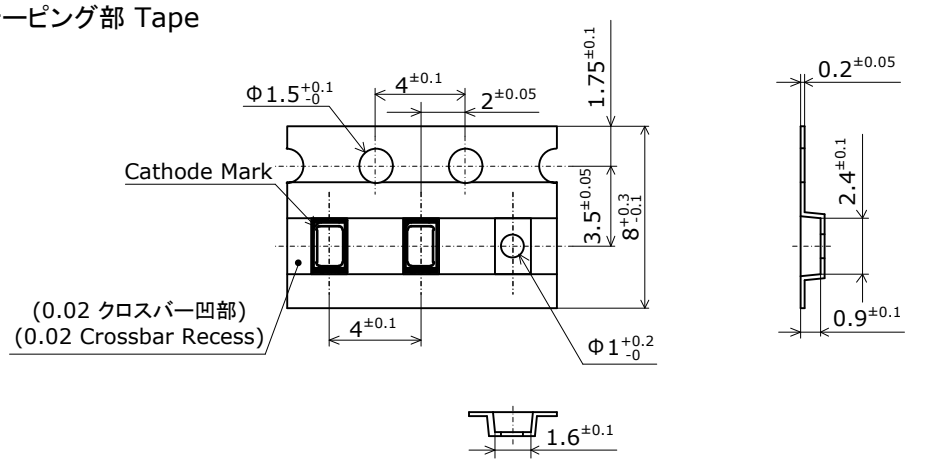
* Once the LEDs have been soldered to a PCB, it should not be repaired/reworked. If it must be done, using a double-head soldering iron is strongly recommended. Ensure that sufficient verification is performed prior to use to ensure that the repair/rework has not caused the LED characteristics to deteriorate.
* When soldering, do not apply stress to the LED while the LED is hot.
* When using an automatic pick-and-place machine, choose an appropriate nozzle for this LED. Using a pick-and-place nozzle with a smaller diameter than the size of the LED's emitting surface will cause damage to the emitting surface causing a catastrophic failure (i.e. the LED not to illuminate).
* The soldering pad pattern above is a general recommendation for LEDs to be mounted without issues; if a high degree of precision is required for the chosen application (i.e. high-density mounting), ensure that the soldering pad pattern is optimized.
* Consider factors such as the reflow soldering temperature, hand soldering temperature, etc. when choosing the solder.
* When flux is used, it should be a halogen free flux. Ensure that the manufacturing process is not designed in a manner where the flux will come in contact with the LEDs.
* Ensure that there are no issues with the type and amount of solder that is being used.

TAPE AND REEL DIMENSIONS

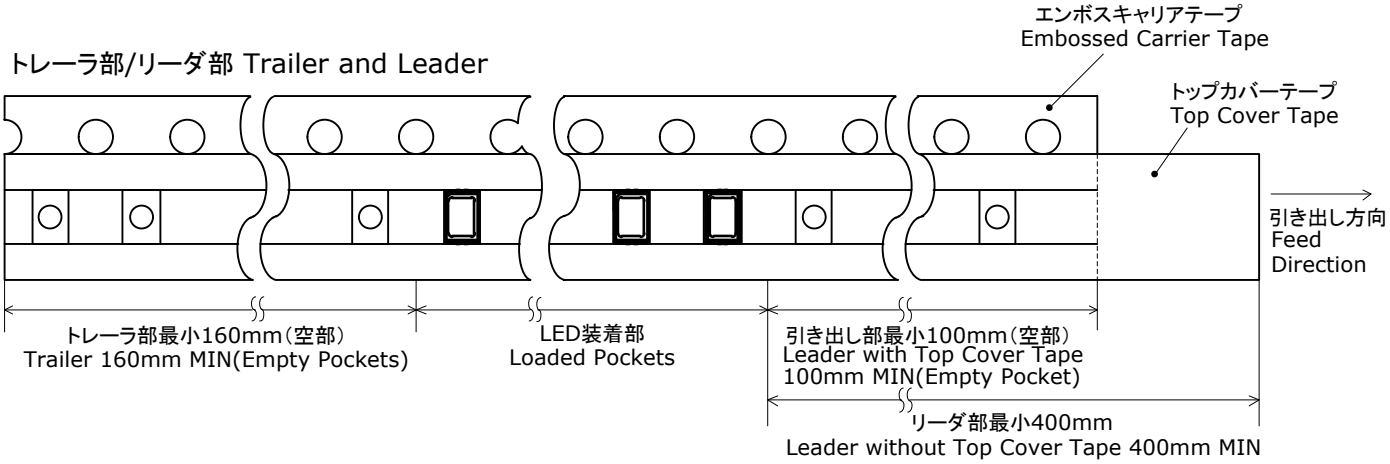
Part No. Nxxx146x
No. STS-DA7-8943B

(単位 Unit: mm)

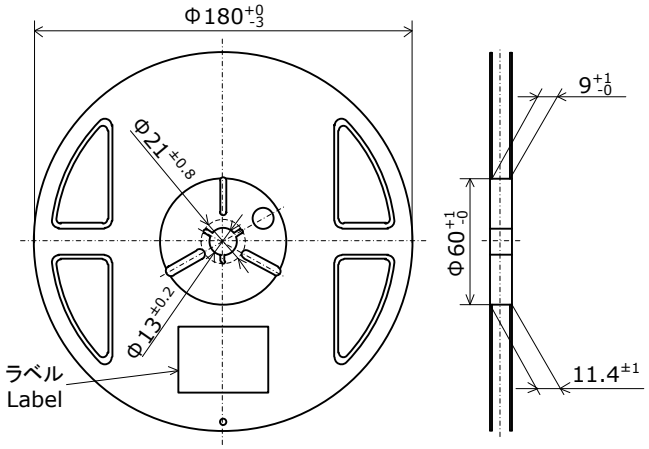
テーピング部 Tape



トレーラ部/リーダ部 Trailer and Leader



リール部 Reel

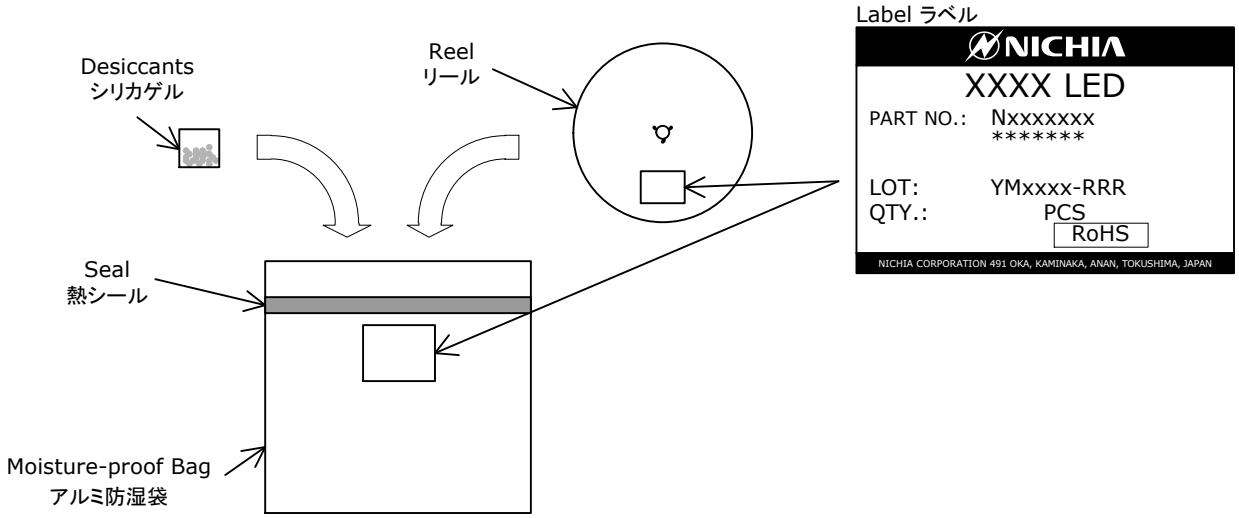


* 数量は1リールにつき 4500個入りです。
  Reel Size: 4500pcs
* 実装作業の中断などでエンボスキャリアテープをリールに巻き取る場合、
  エンボスキャリアテープを強く(10N以上)締めないで下さい。
  LEDがカバーテープに貼り付く可能性があります。
  When the tape is rewound due to work interruptions,
  no more than 10N should be applied to
  the embossed carrier tape.
  The LEDs may stick to the top cover tape.
* JIS C 0806電子部品テーピングに準拠しています。
  The tape packing method complies with JIS C 0806
  (Packaging of Electronic Components on Continuous Tapes).

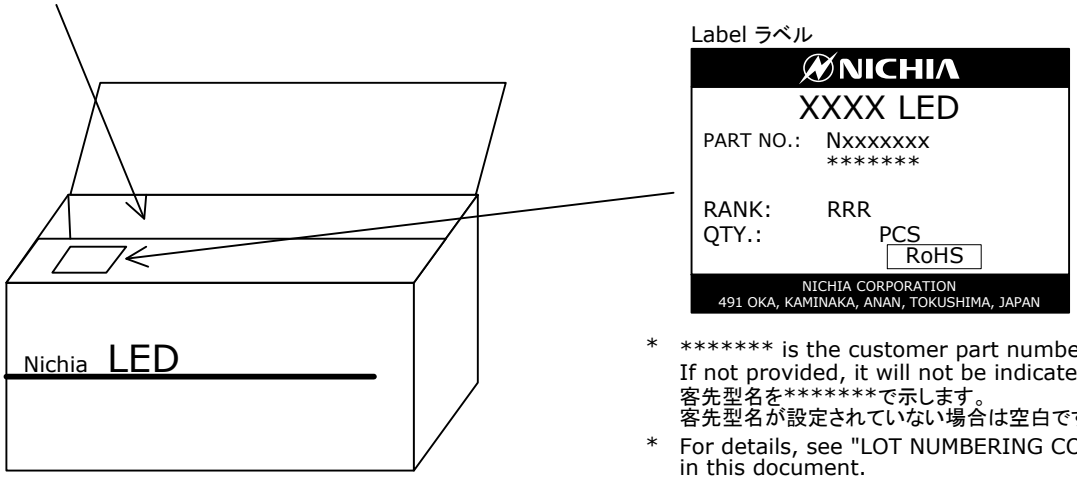
PACKAGING - TAPE & REEL

Reels are shipped with desiccants in heat-sealed moisture-proof bags.
シリカゲルとともにリールをアルミ防湿袋に入れ、熱シールにより封をします。

Part No. Nxxxxxxx
No. STS-DA7-0006F



Moisture-proof bags are packed in cardboard boxes with corrugated partitions.
アルミ防湿袋を並べて入れ、ダンボールで仕切ります。



* ******* is the customer part number.
If not provided, it will not be indicated on the label.
客先型名を*******で示します。
客先型名が設定されていない場合は空白です。
* For details, see "LOT NUMBERING CODE" in this document.
ロット表記方法についてはロット番号の項を参照して下さい。
* The label does not have the RANK field for un-ranked products.
ランク分けがない場合はランク表記はありません。

* Products shipped on tape and reel are packed in a moisture-proof bag.
They are shipped in cardboard boxes to protect them from external forces during transportation.
本製品はテーピングしたのち、輸送の衝撃から保護するためダンボールで梱包します。
* Do not drop or expose the box to external forces as it may damage the products.
取り扱いに際して、落下させたり、強い衝撃を与えたりしますと、製品を損傷させる原因になりますので注意して下さい。
* Do not expose to water. The box is not water-resistant.
ダンボールには防水加工がされておりませんので、梱包箱が水に濡れないよう注意して下さい。
* Using the original package material or equivalent in transit is recommended.
輸送、運搬に際して弊社よりの梱包状態あるいは同等の梱包を行って下さい。

LOT NUMBERING CODE

Lot Number is presented by using the following alphanumeric code.

YMxxxx - RRR

Y - Year

Year	Y
2023	N
2024	O
2025	P
2026	Q
2027	R
2028	S

M - Month

Month	M	Month	M
1	1	7	7
2	2	8	8
3	3	9	9
4	4	10	A
5	5	11	B
6	6	12	C

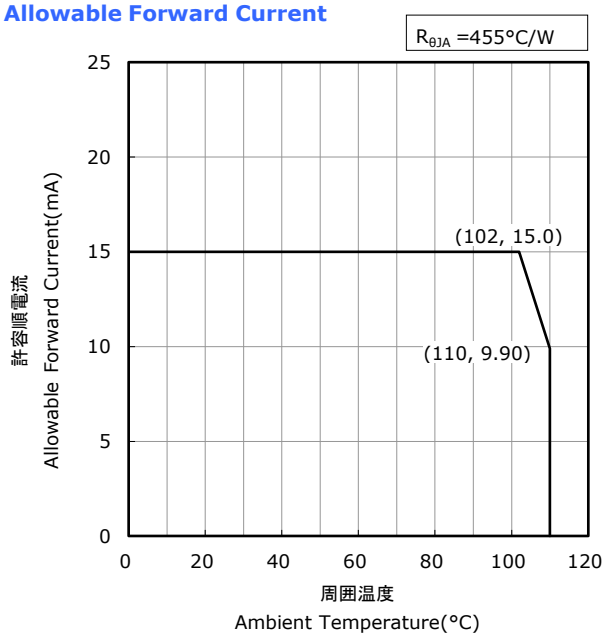
xxxx-Nichia's Product Number

RRR-Ranking by Color Coordinates, Ranking by Luminous Intensity

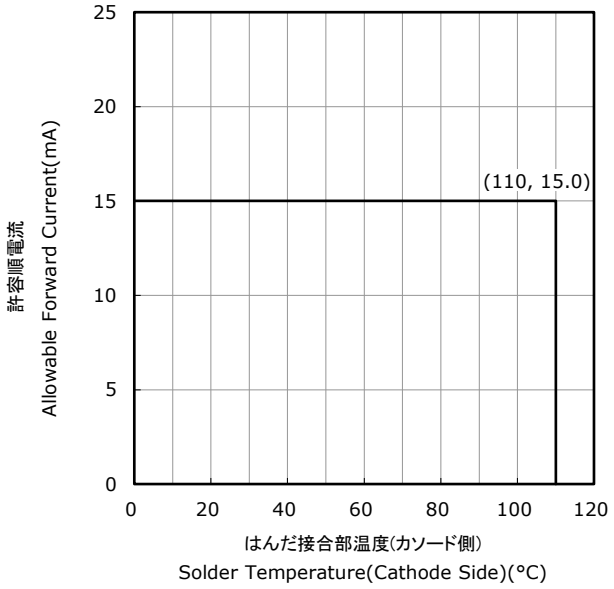
DERATING CHARACTERISTICS

NHSx146x
管理番号 No. STS-DA7-8525C

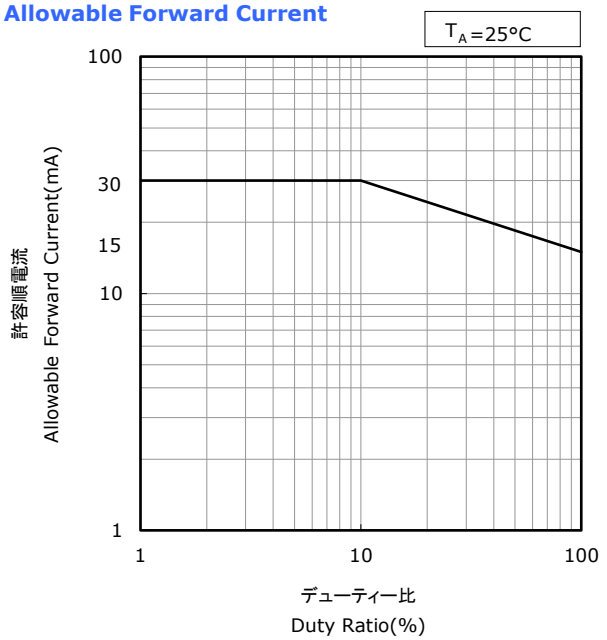
周囲温度–許容順電流特性
Ambient Temperature vs Allowable Forward Current



はんだ接合部温度(カソード側)–許容順電流特性
Solder Temperature(Cathode Side) vs Allowable Forward Current



デューティー比–許容順電流特性
Duty Ratio vs Allowable Forward Current

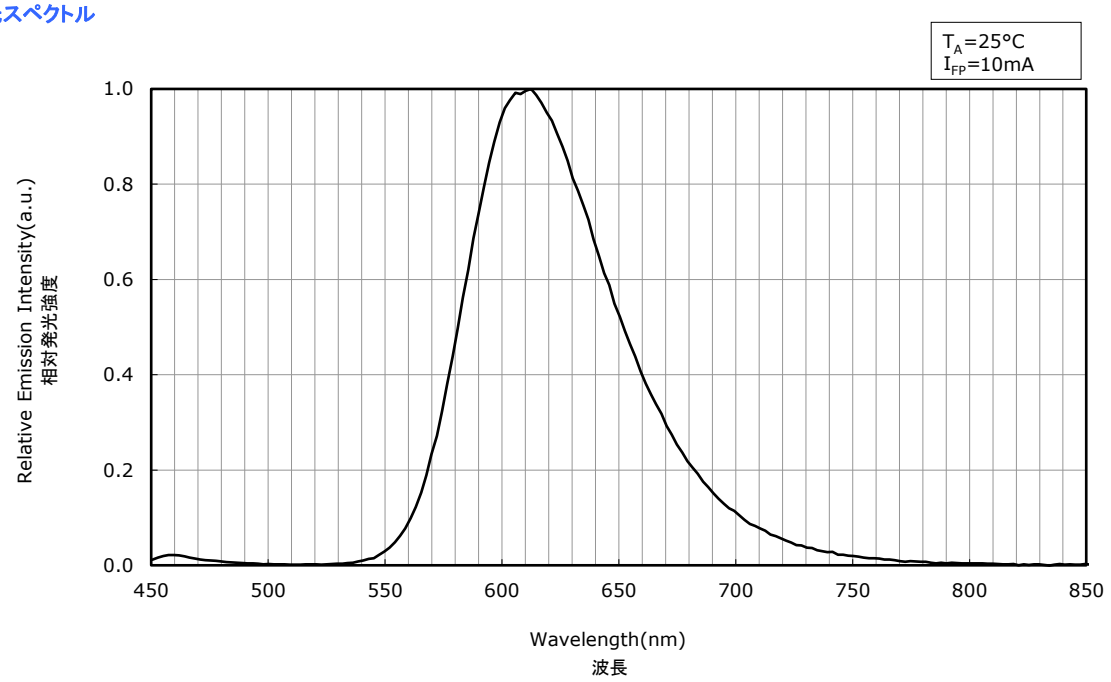


OPTICAL CHARACTERISTICS

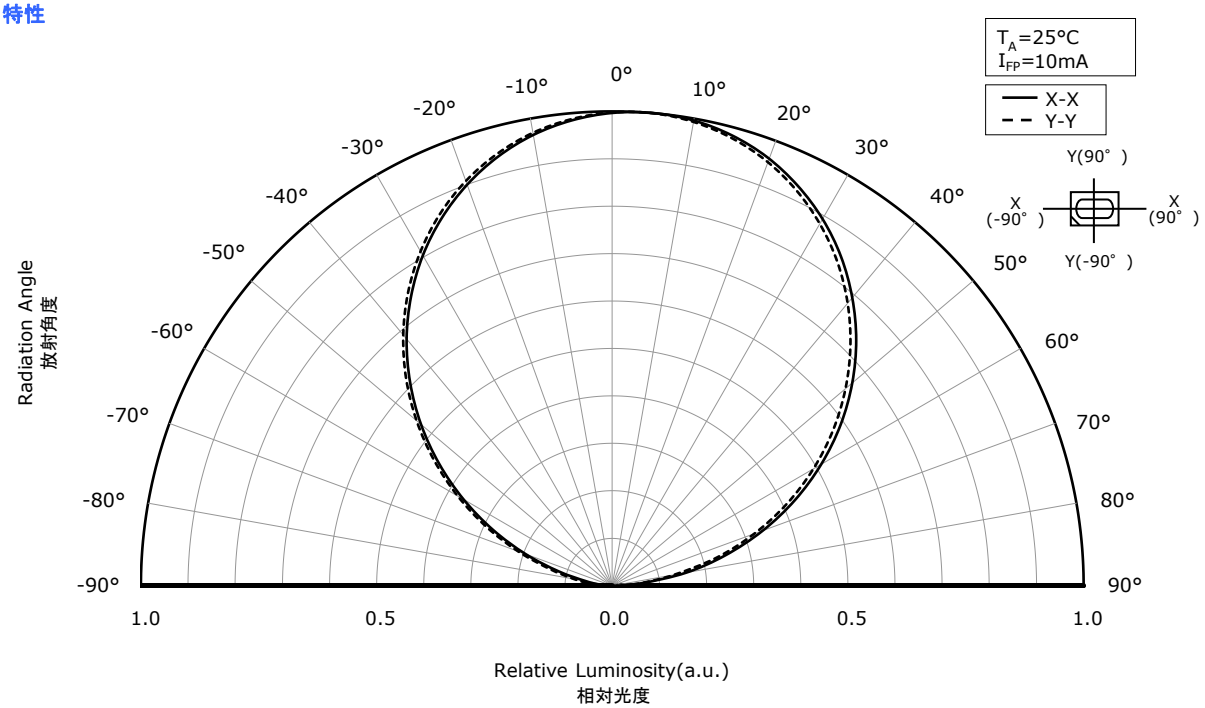
* All characteristics shown are for reference only and are not guaranteed.
本特性は参考です。

Part No. NHSR146A
No. STS-DA7-17203

Spectrum
発光スペクトル



Directivity
指向特性



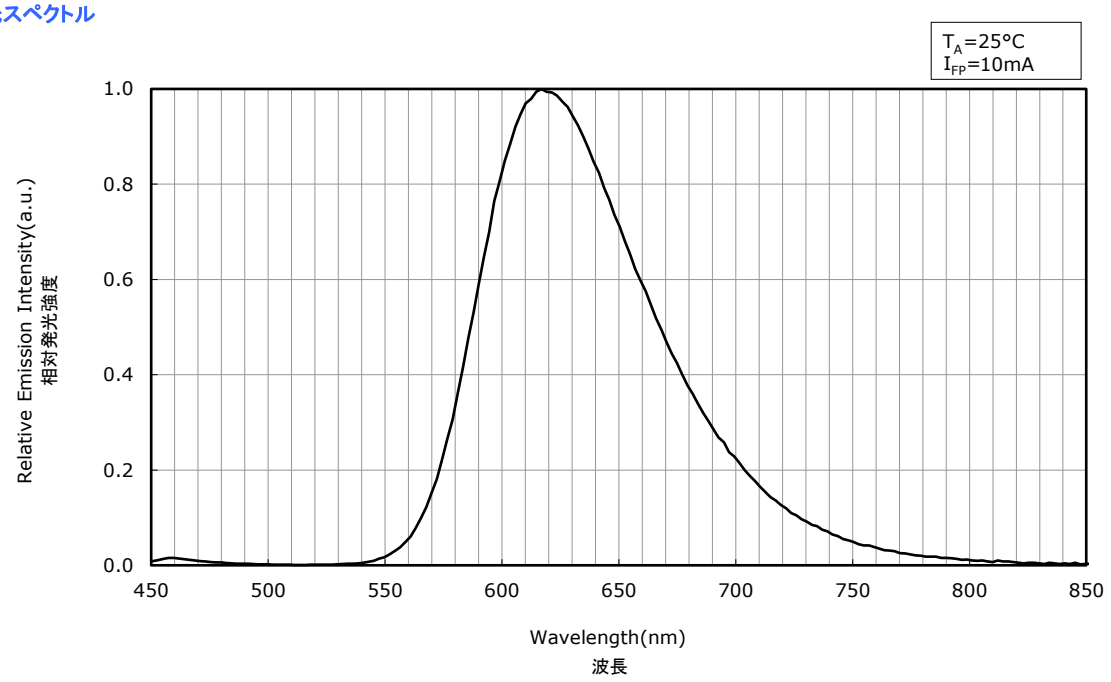
* The graphs above show the characteristics for Or5z LEDs, including sub-bins, of this product.
本特性は色度ランクOr5z(ランク座標範囲内の特別ランクを含む)に対応しています。

OPTICAL CHARACTERISTICS

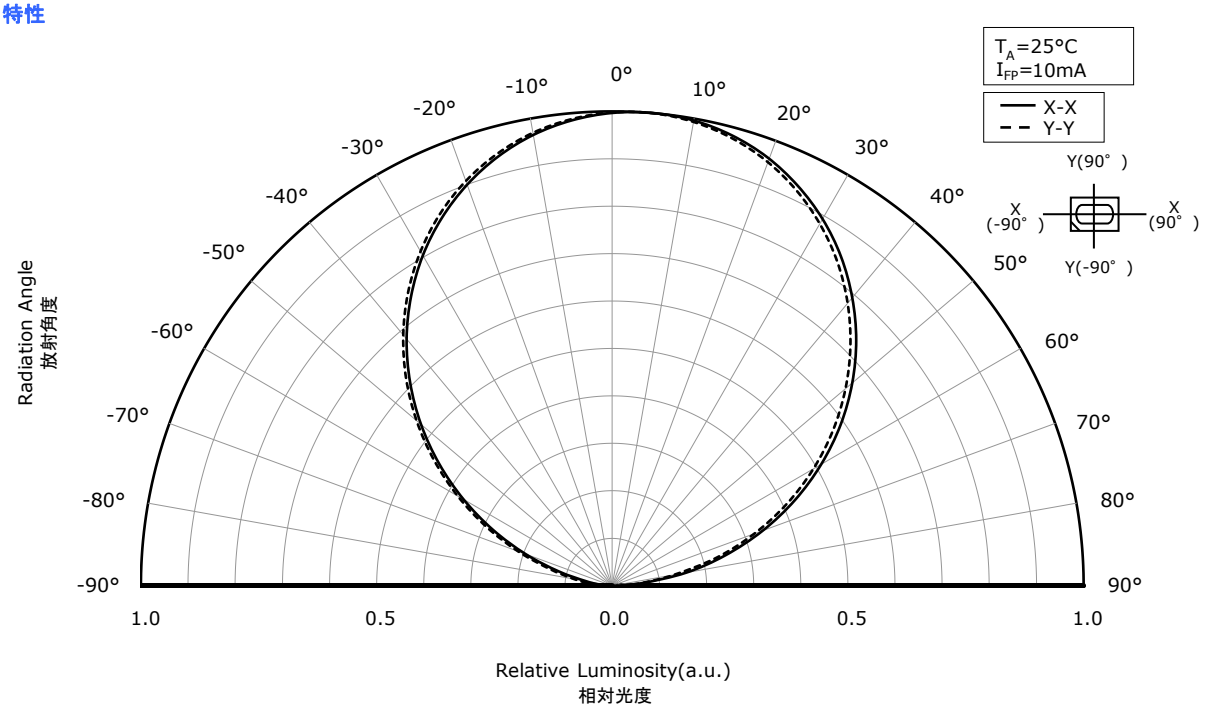
* All characteristics shown are for reference only and are not guaranteed.
本特性は参考です。

Part No. NHSR146A
No. STS-DA7-17204

Spectrum
発光スペクトル



Directivity
指向特性



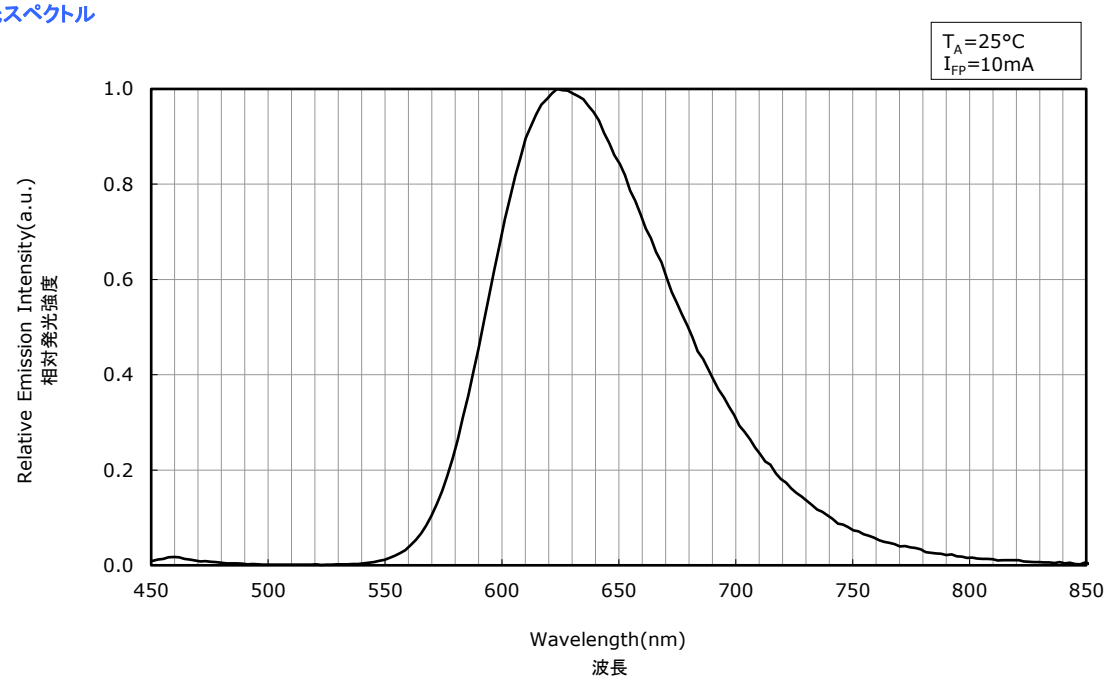
* The graphs above show the characteristics for Or6z LEDs, including sub-bins, of this product.
本特性は色度ランクOr6z(ランク座標範囲内の特別ランクを含む)に対応しています。

OPTICAL CHARACTERISTICS

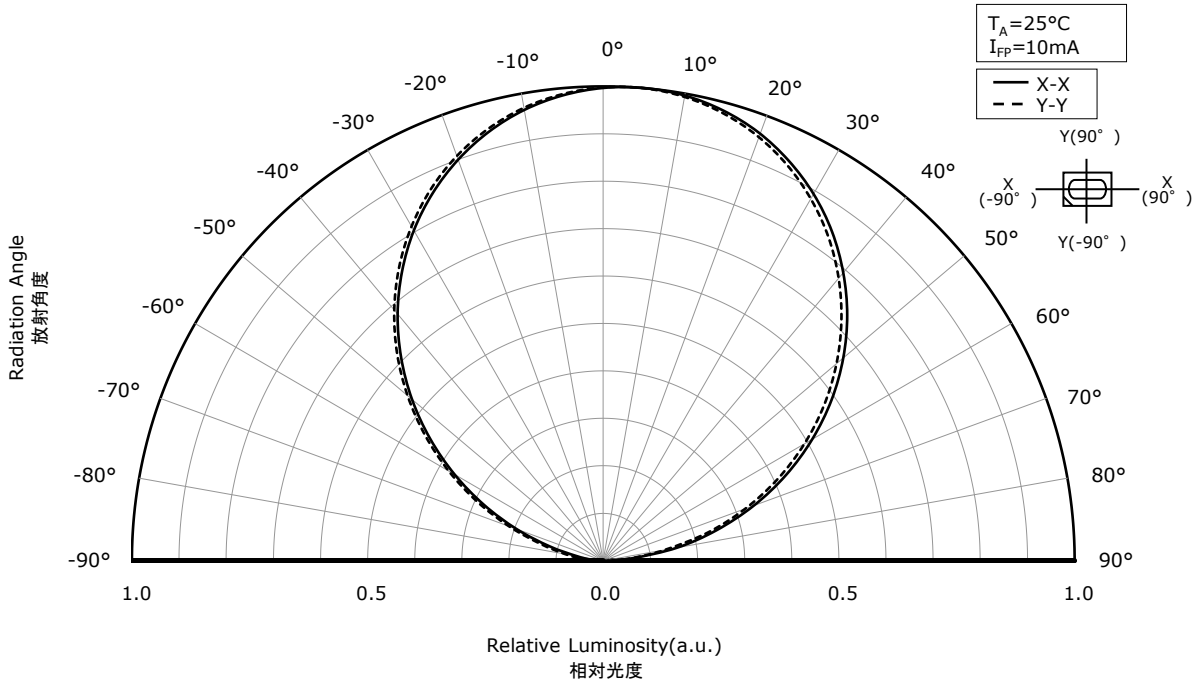
* All characteristics shown are for reference only and are not guaranteed.
本特性は参考です。

Part No. NHSR146A
No. STS-DA7-17205

Spectrum
発光スペクトル



Directivity
指向特性



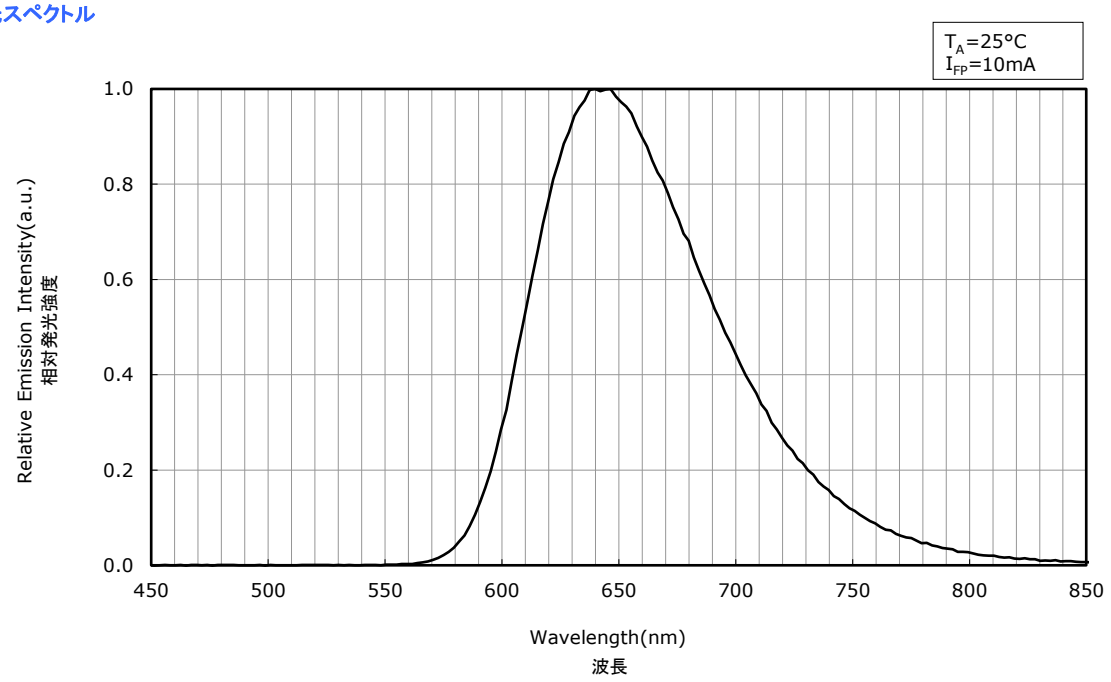
* The graphs above show the characteristics for Or7z LEDs, including sub-bins, of this product.
本特性は色度ランクOr7z(ランク座標範囲内の特別ランクを含む)に対応しています。

OPTICAL CHARACTERISTICS

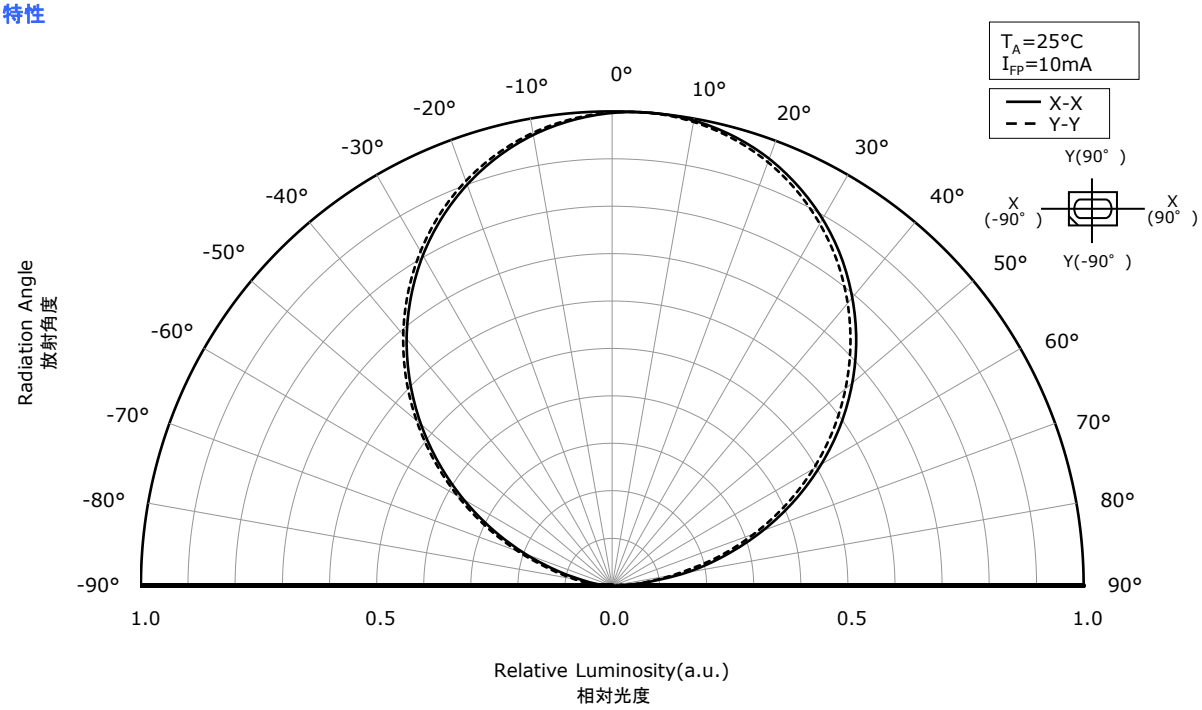
* All characteristics shown are for reference only and are not guaranteed.
本特性は参考です。

Part No. NHSR146A
No. STS-DA7-17206

Spectrum
発光スペクトル



Directivity
指向特性



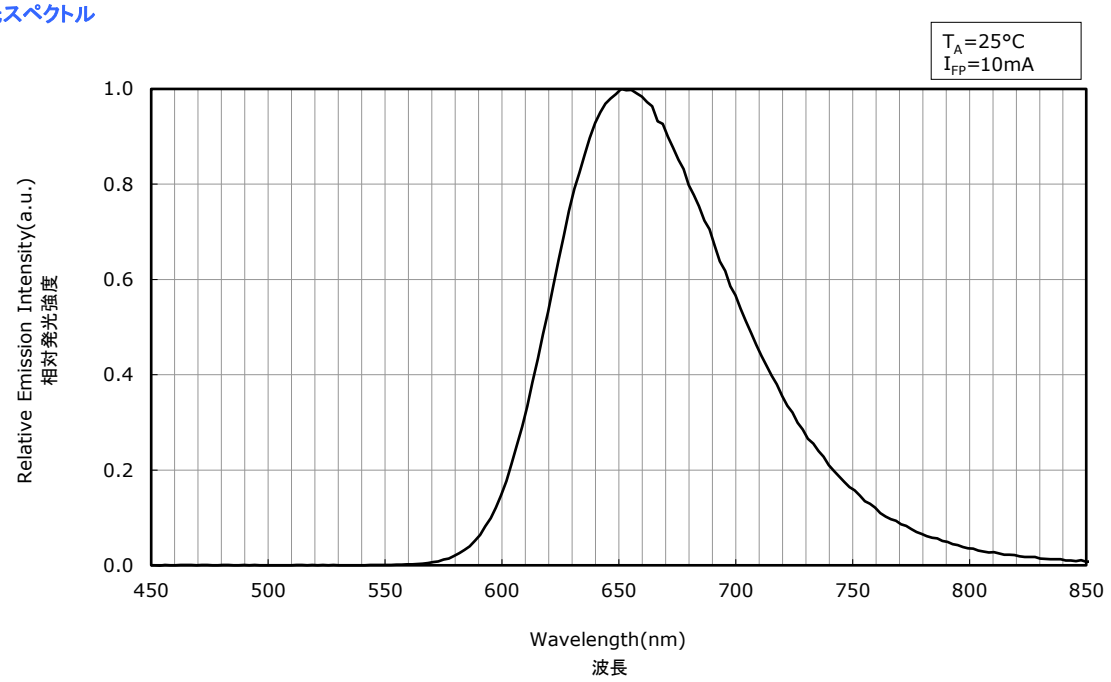
* The graphs above show the characteristics for R13z LEDs, including sub-bins, of this product.
本特性は色度ランクR13z(ランク座標範囲内の特別ランクを含む)に対応しています。

OPTICAL CHARACTERISTICS

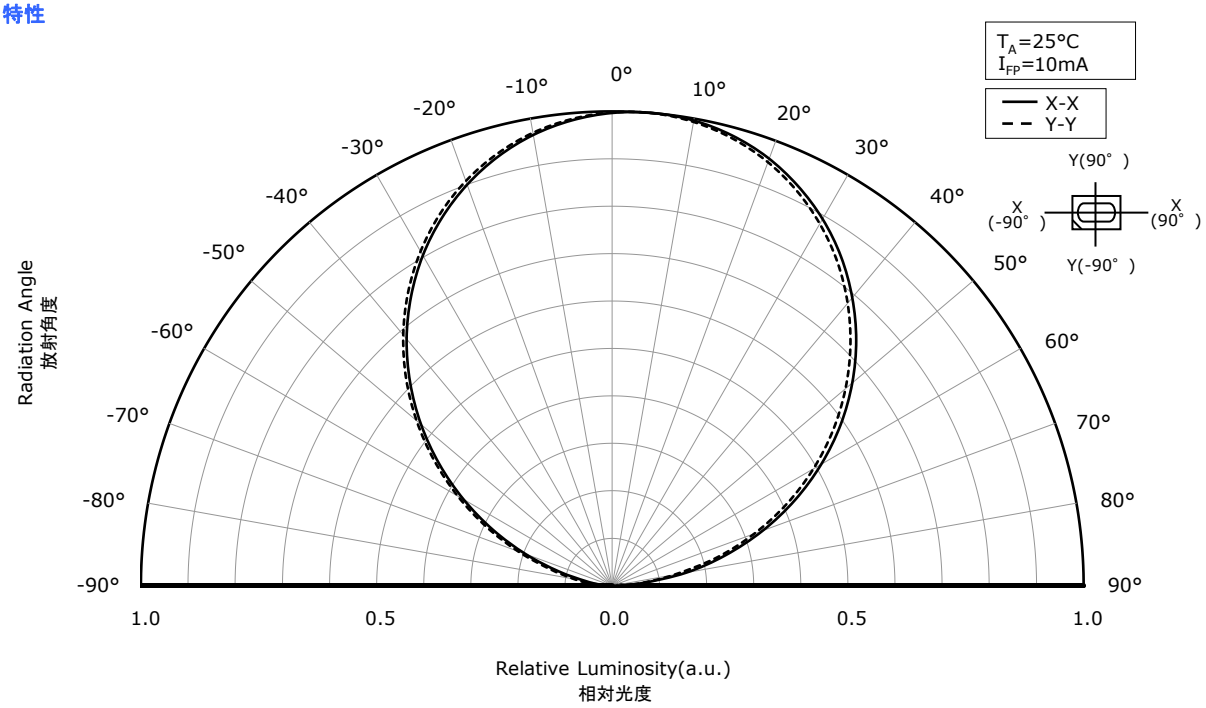
* All characteristics shown are for reference only and are not guaranteed.
本特性は参考です。

Part No. NHSR146A
No. STS-DA7-17207

Spectrum
発光スペクトル



Directivity
指向特性



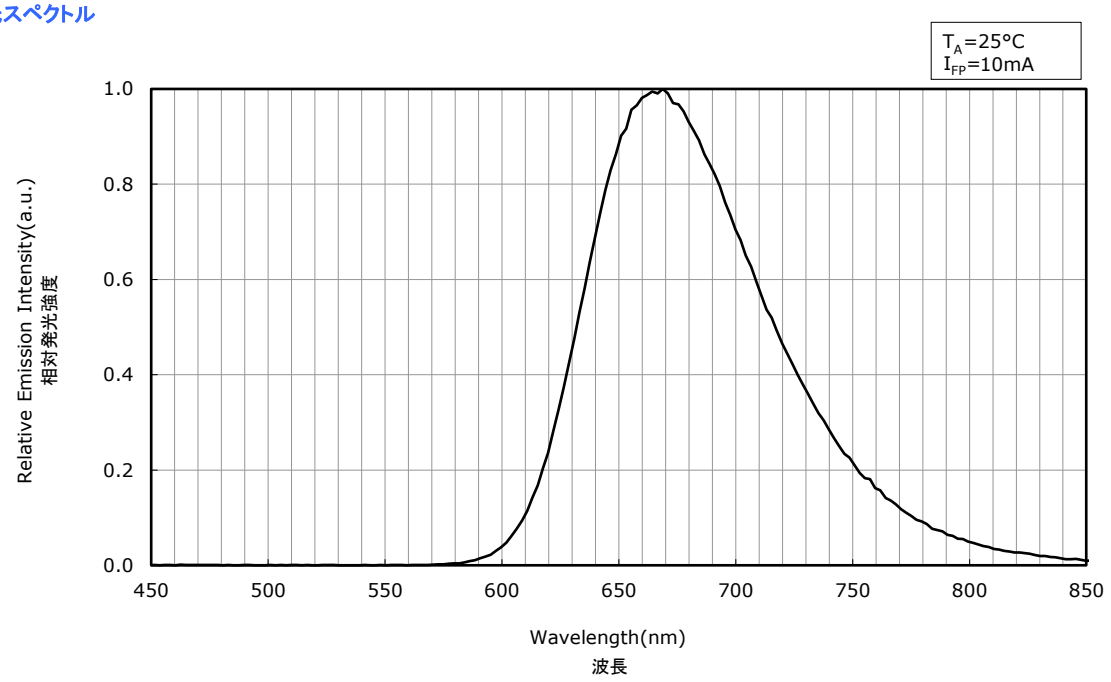
* The graphs above show the characteristics for R14z LEDs, including sub-bins, of this product.
本特性は色度ランクR14z(ランク座標範囲内の特別ランクを含む)に対応しています。

OPTICAL CHARACTERISTICS

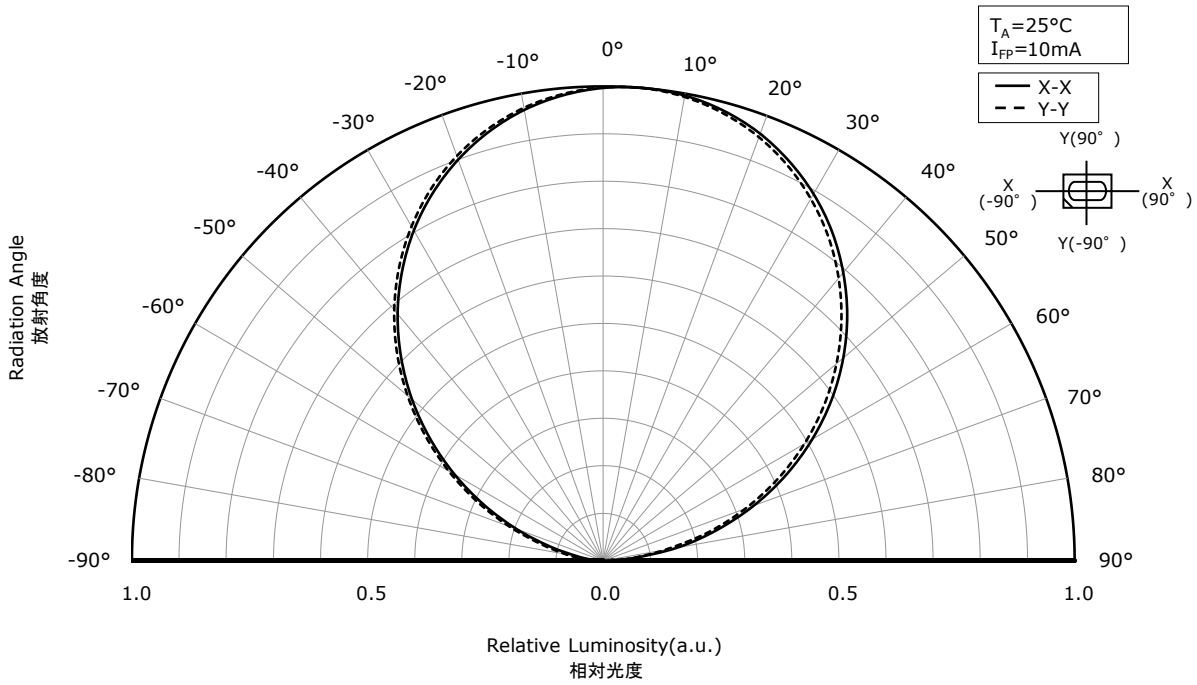
* All characteristics shown are for reference only and are not guaranteed.
本特性は参考です。

Part No. NHSR146A
No. STS-DA7-17208

Spectrum
発光スペクトル



Directivity
指向特性



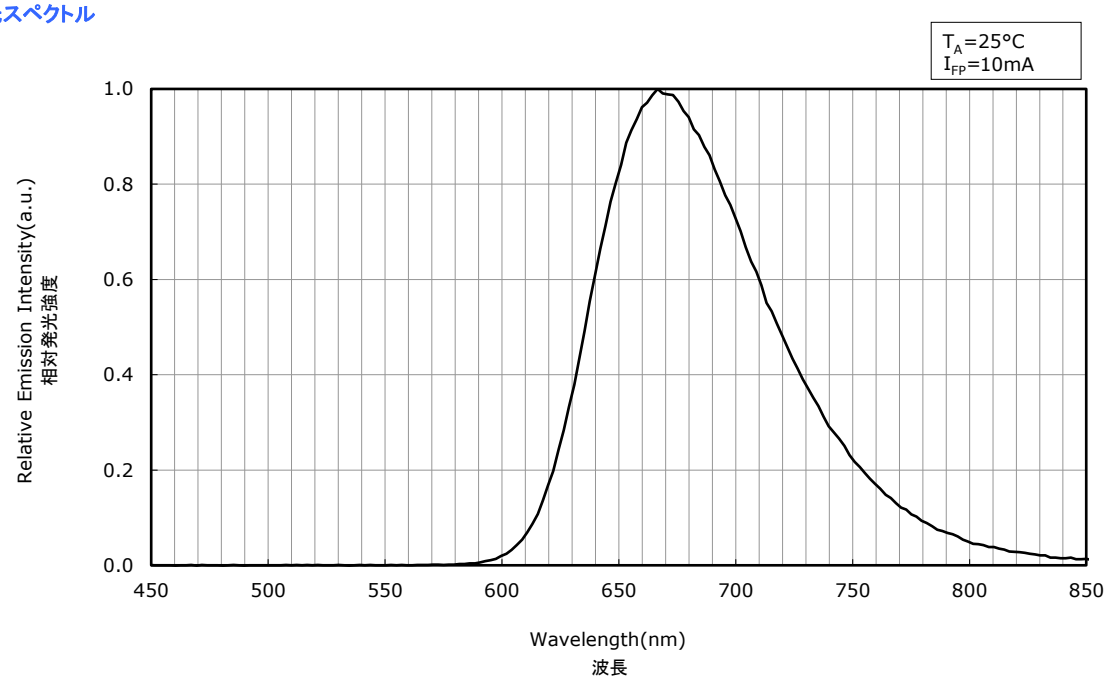
* The graphs above show the characteristics for R15z LEDs, including sub-bins, of this product.
本特性は色度ランクR15z(ランク座標範囲内の特別ランクを含む)に対応しています。

OPTICAL CHARACTERISTICS

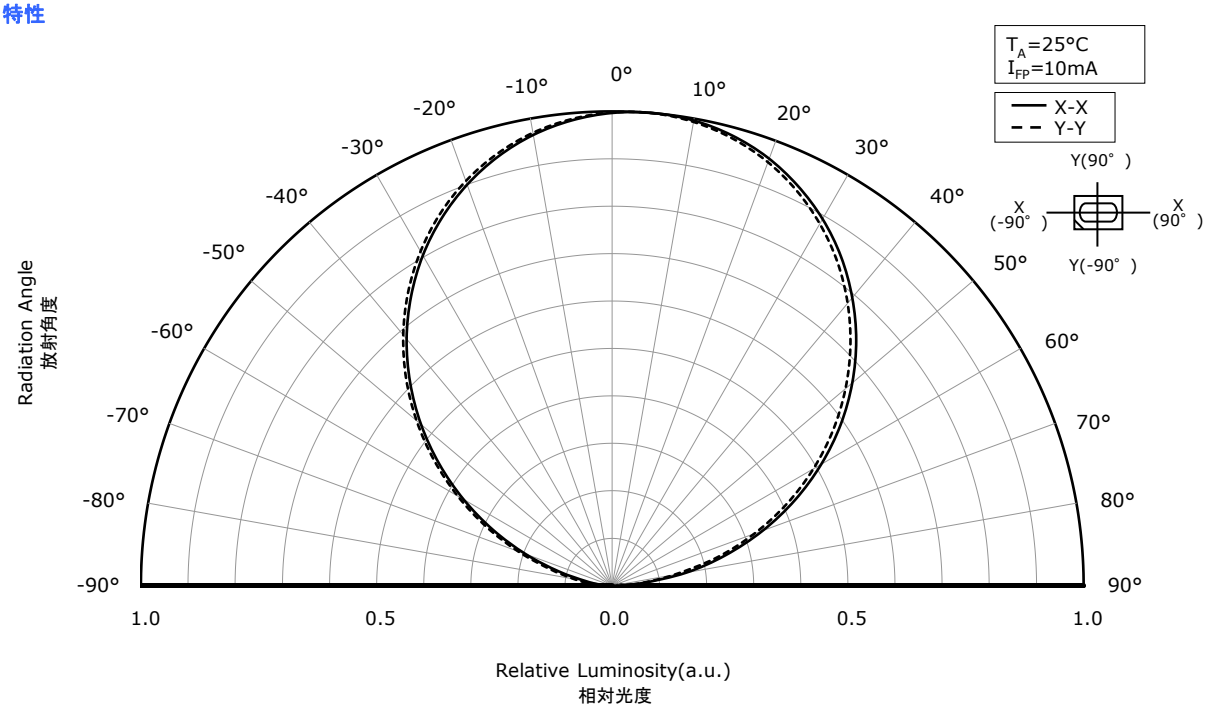
* All characteristics shown are for reference only and are not guaranteed.
本特性は参考です。

Part No. NHSR146A
No. STS-DA7-17209

Spectrum
発光スペクトル



Directivity
指向特性



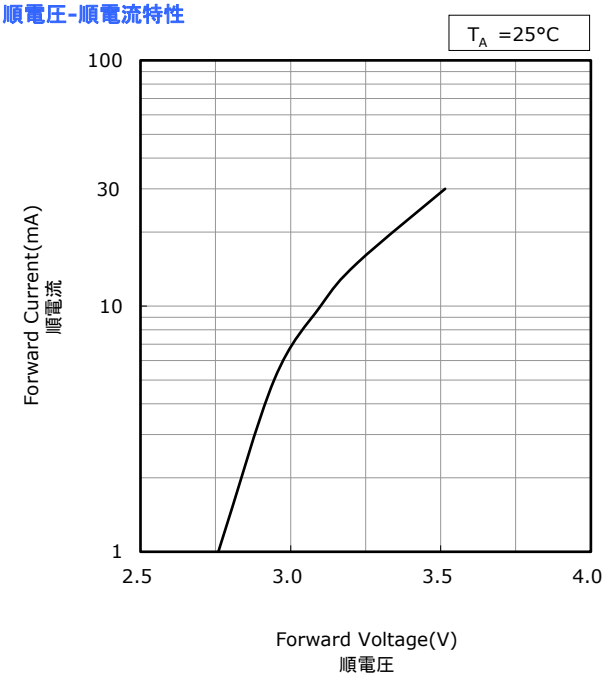
* The graphs above show the characteristics for R16z LEDs, including sub-bins, of this product.
本特性は色度ランクR16z(ランク座標範囲内の特別ランクを含む)に対応しています。

FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

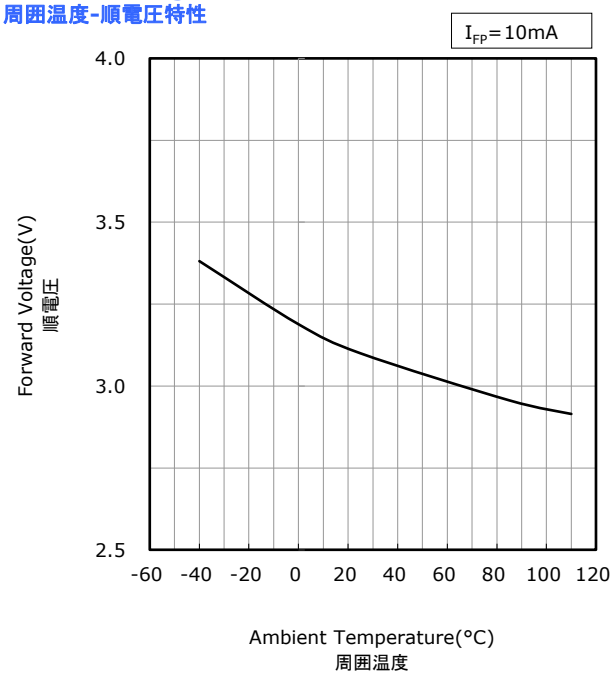
＊ All characteristics shown are for reference only and are not guaranteed.
本特性は参考です。

Part No. NHSR146A
No. STS-DA7-17210

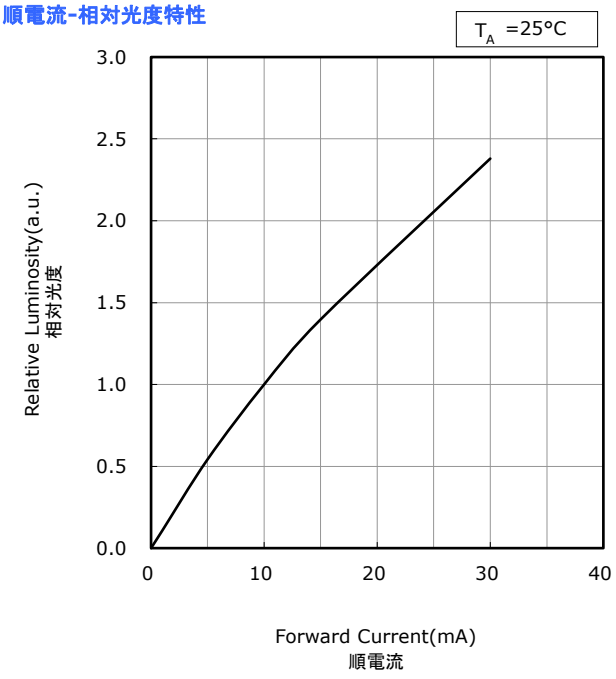
Forward Voltage vs Forward Current
順電圧-順電流特性



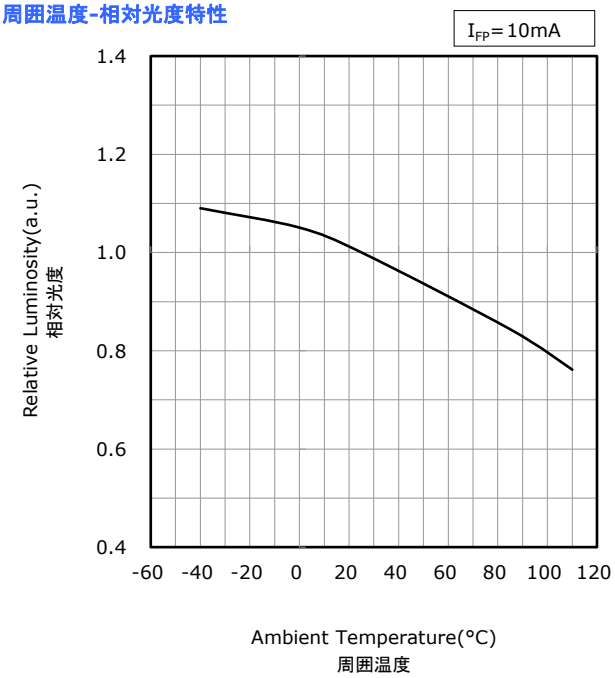
Ambient Temperature vs Forward Voltage
周囲温度-順電圧特性



Forward Current vs Relative Luminosity
順電流-相対光度特性



Ambient Temperature vs Relative Luminosity
周囲温度-相対光度特性



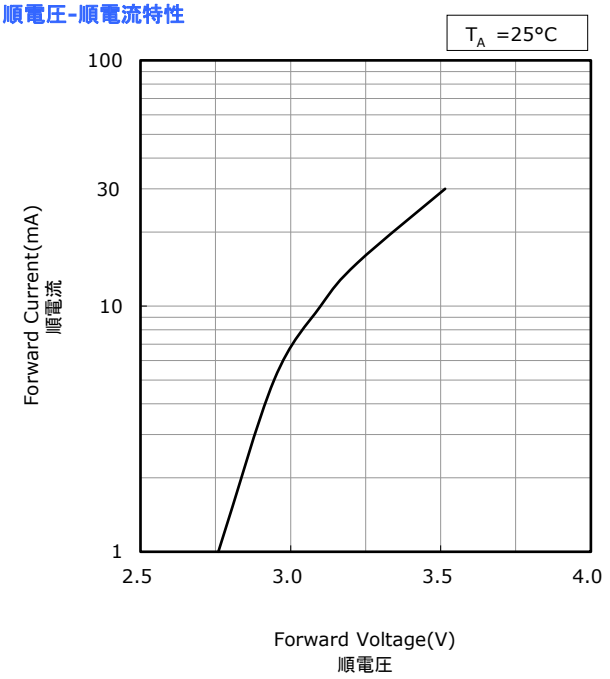
＊ The graphs above show the characteristics for Or5z LEDs, including sub-bins, of this product.
本特性は色度ランクOr5z(ランク座標範囲内の特別ランクを含む)に対応しています。

FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

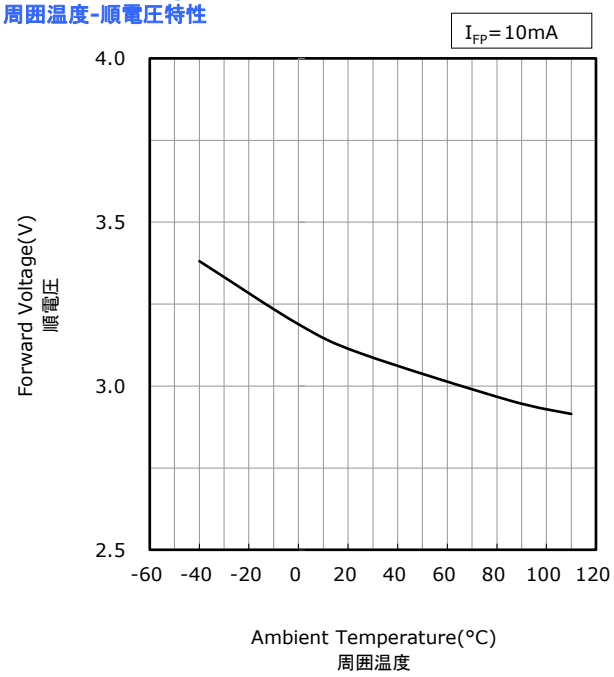
＊ All characteristics shown are for reference only and are not guaranteed.
本特性は参考です。

Part No. NHSR146A
No. STS-DA7-17211

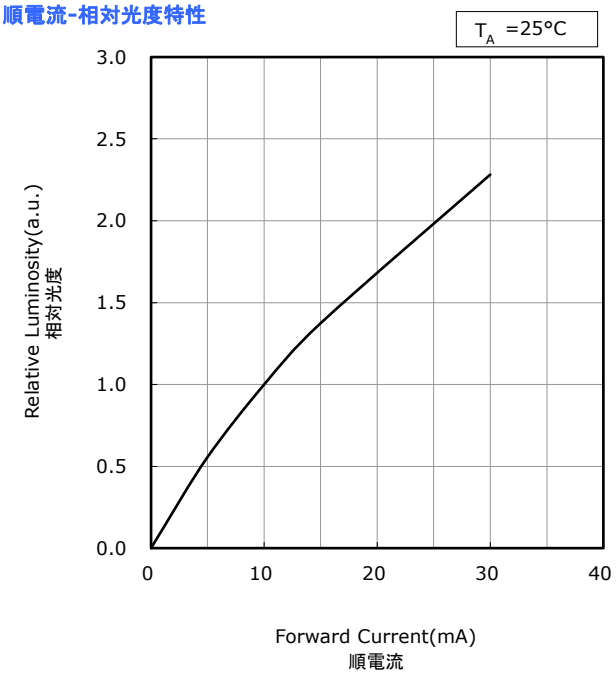
Forward Voltage vs Forward Current
順電圧-順電流特性



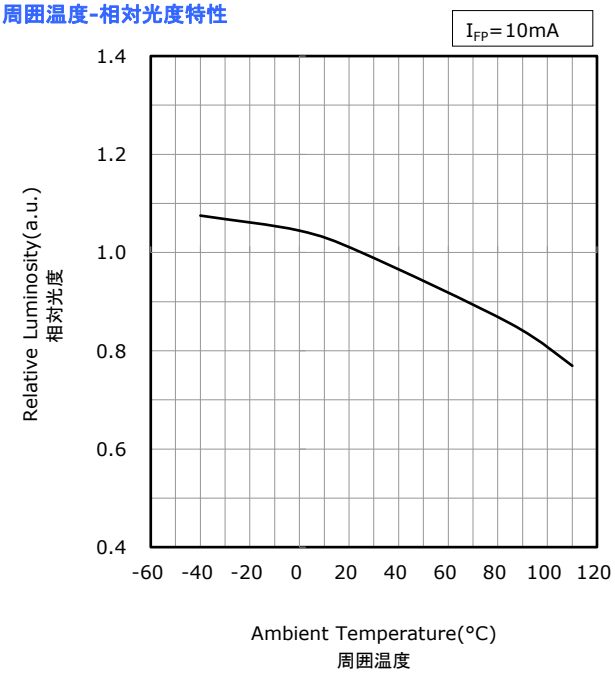
Ambient Temperature vs Forward Voltage
周囲温度-順電圧特性



Forward Current vs Relative Luminosity
順電流-相対光度特性



Ambient Temperature vs Relative Luminosity
周囲温度-相対光度特性



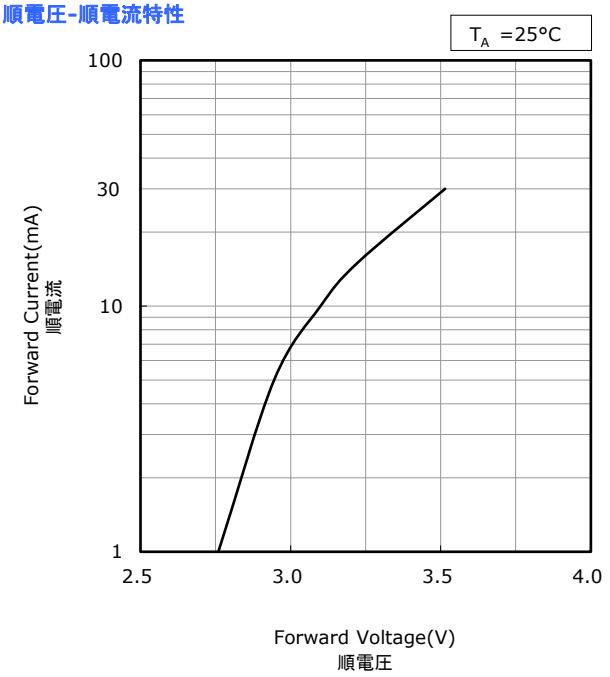
＊ The graphs above show the characteristics for Or6z LEDs, including sub-bins, of this product.
本特性は色度ランクOr6z(ランク座標範囲内の特別ランクを含む)に対応しています。

FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

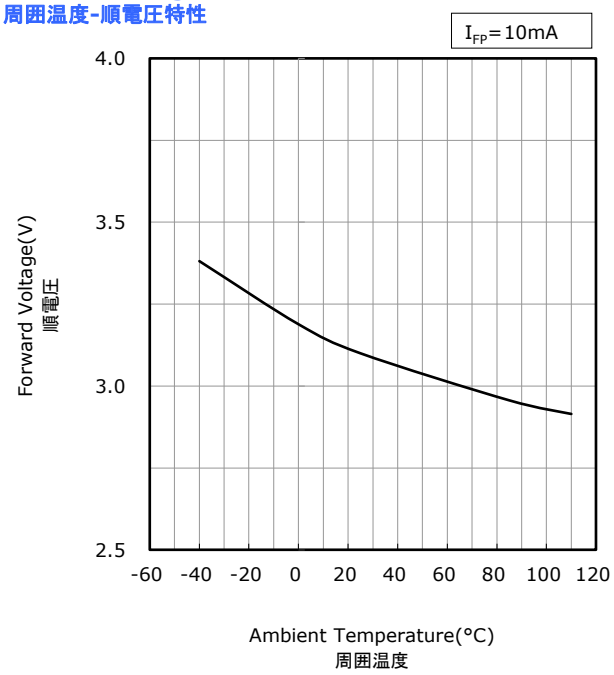
＊ All characteristics shown are for reference only and are not guaranteed.
本特性は参考です。

Part No. NHSR146A
No. STS-DA7-17212

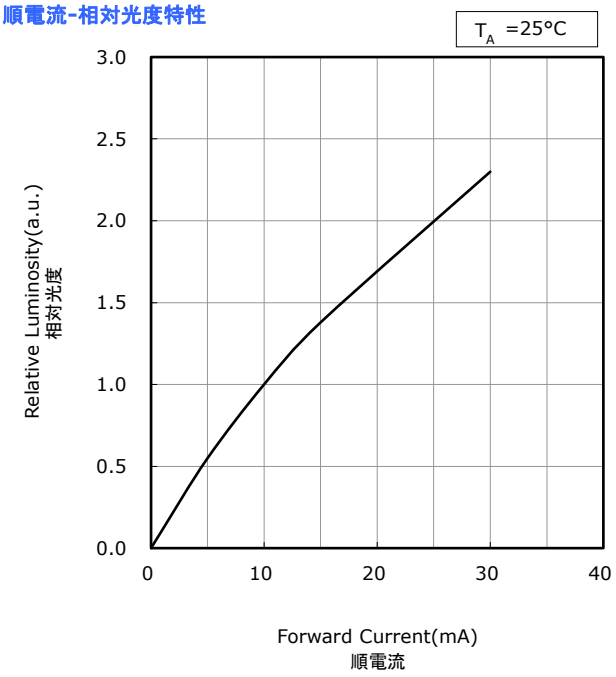
Forward Voltage vs Forward Current
順電圧-順電流特性



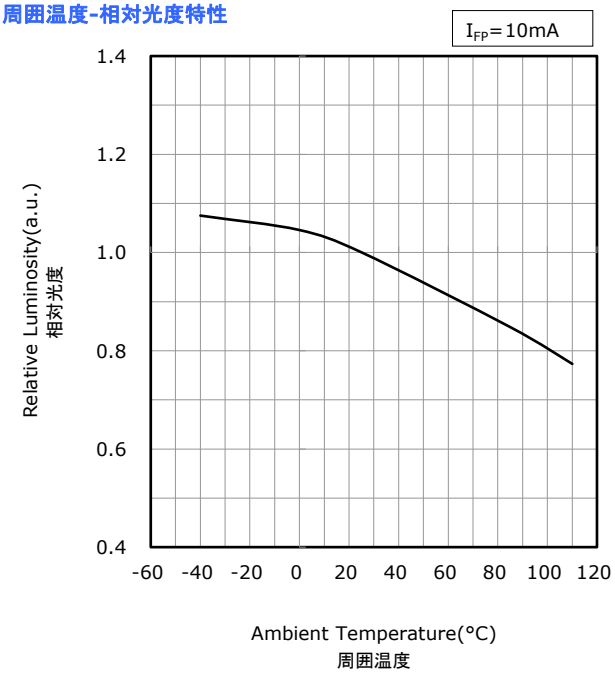
Ambient Temperature vs Forward Voltage
周囲温度-順電圧特性



Forward Current vs Relative Luminosity
順電流-相対光度特性



Ambient Temperature vs Relative Luminosity
周囲温度-相対光度特性



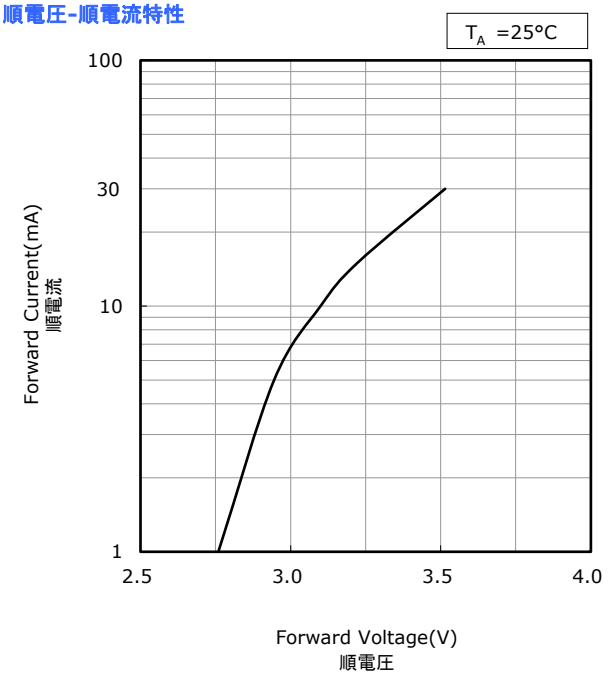
＊ The graphs above show the characteristics for Or7z LEDs, including sub-bins, of this product.
本特性は色度ランクOr7z(ランク座標範囲内の特別ランクを含む)に対応しています。

FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

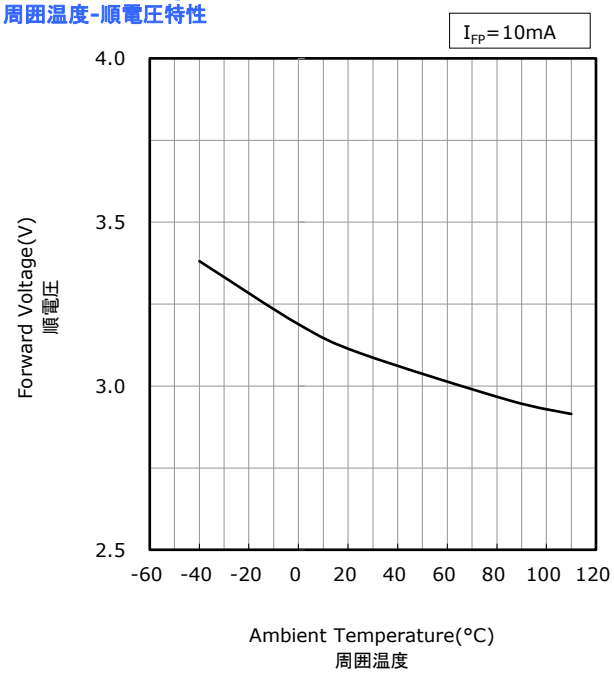
＊ All characteristics shown are for reference only and are not guaranteed.
本特性は参考です。

Part No. NHSR146A
No. STS-DA7-17213

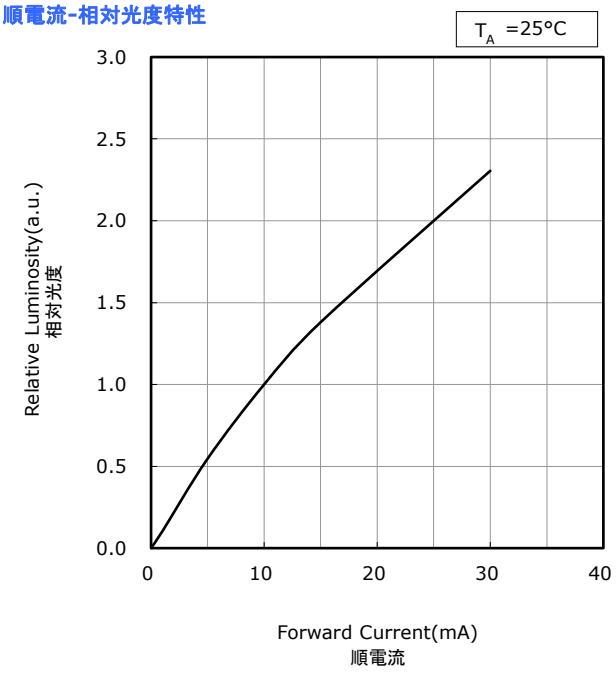
Forward Voltage vs Forward Current
順電圧-順電流特性



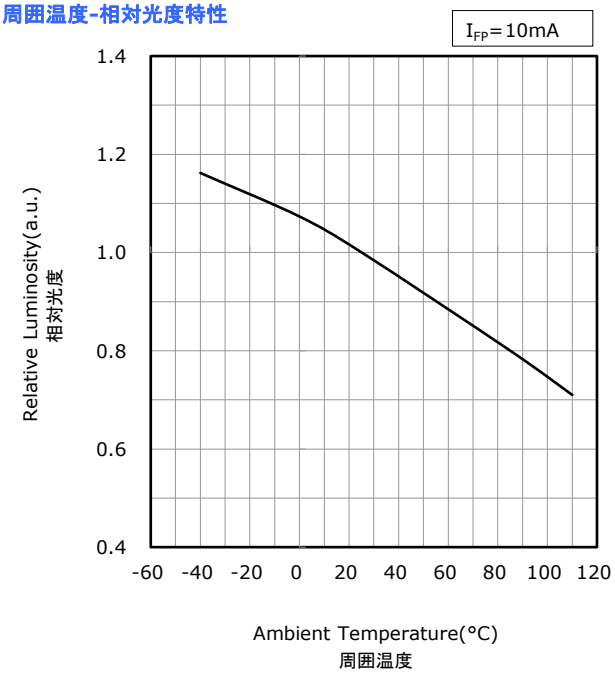
Ambient Temperature vs Forward Voltage
周囲温度-順電圧特性



Forward Current vs Relative Luminosity
順電流-相対光度特性



Ambient Temperature vs Relative Luminosity
周囲温度-相対光度特性



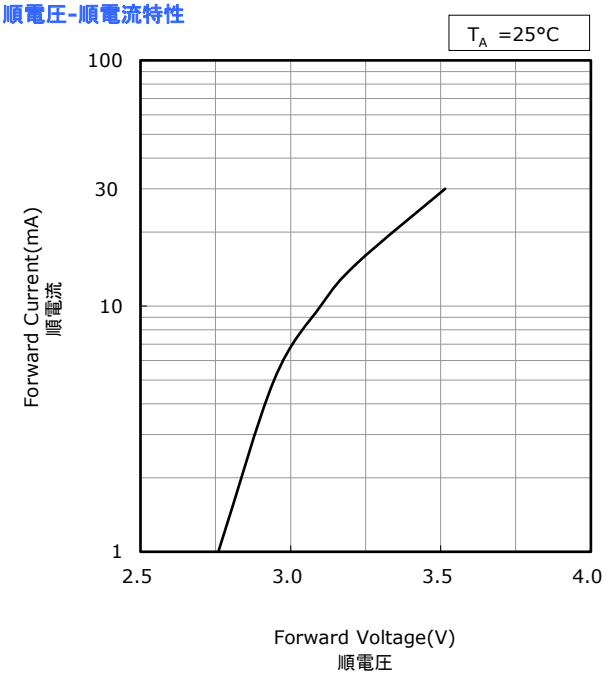
＊ The graphs above show the characteristics for R13z LEDs, including sub-bins, of this product.
本特性は色度ランクR13z(ランク座標範囲内の特別ランクを含む)に対応しています。

FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

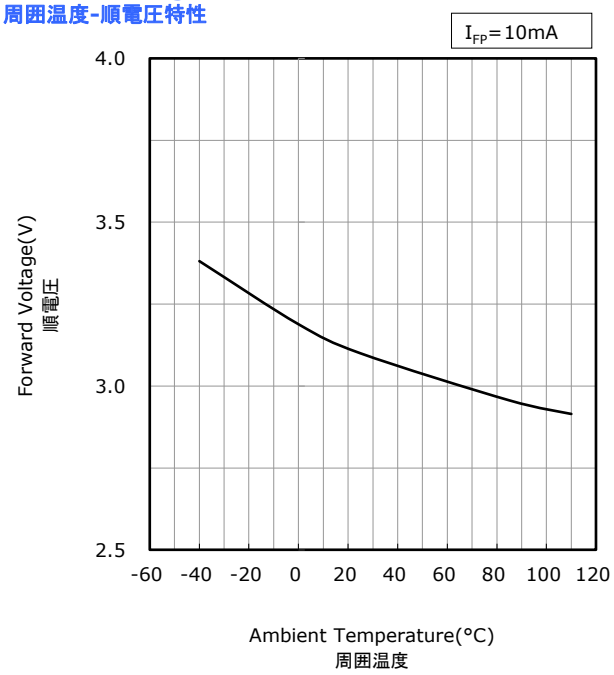
＊ All characteristics shown are for reference only and are not guaranteed.
本特性は参考です。

Part No. NHSR146A
No. STS-DA7-17214

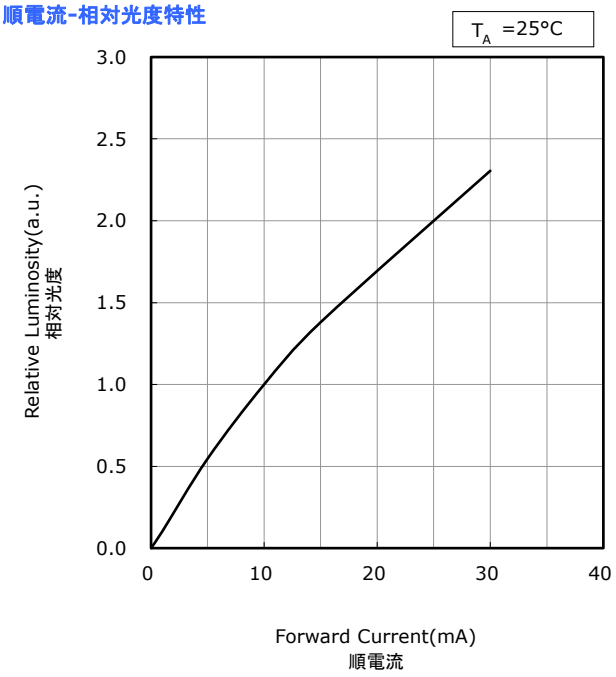
Forward Voltage vs Forward Current
順電圧-順電流特性



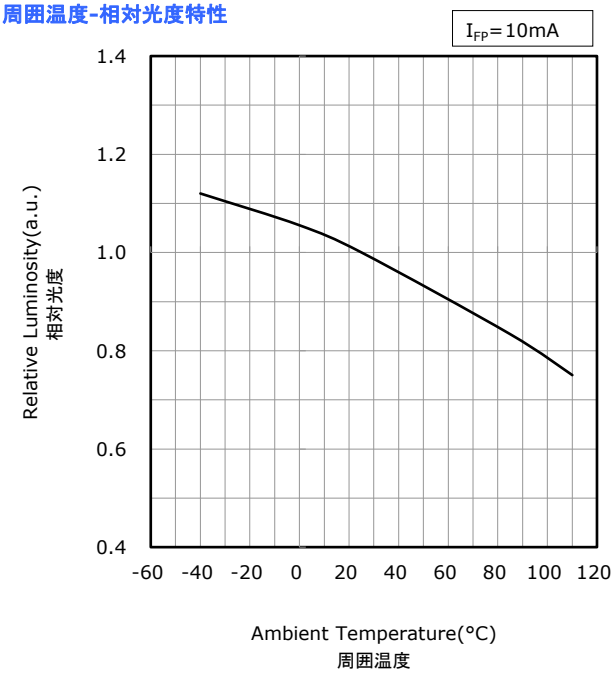
Ambient Temperature vs Forward Voltage
周囲温度-順電圧特性



Forward Current vs Relative Luminosity
順電流-相対光度特性



Ambient Temperature vs Relative Luminosity
周囲温度-相対光度特性



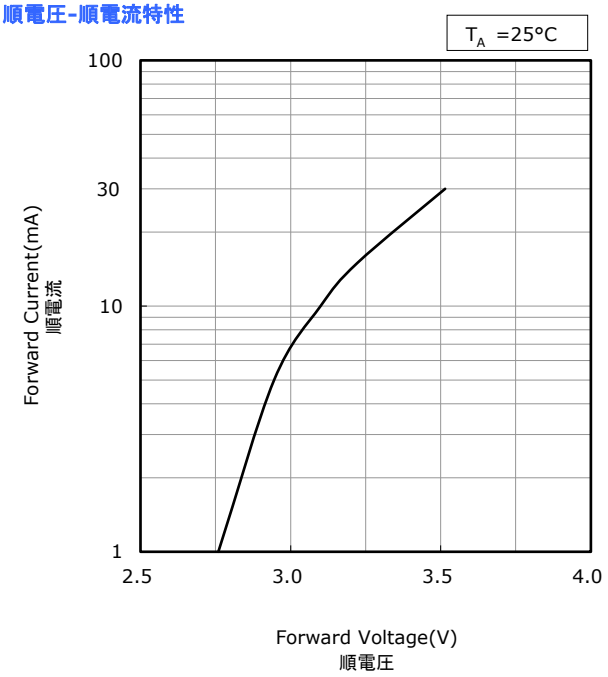
＊ The graphs above show the characteristics for R14z LEDs, including sub-bins, of this product.
本特性は色度ランクR14z(ランク座標範囲内の特別ランクを含む)に対応しています。

FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

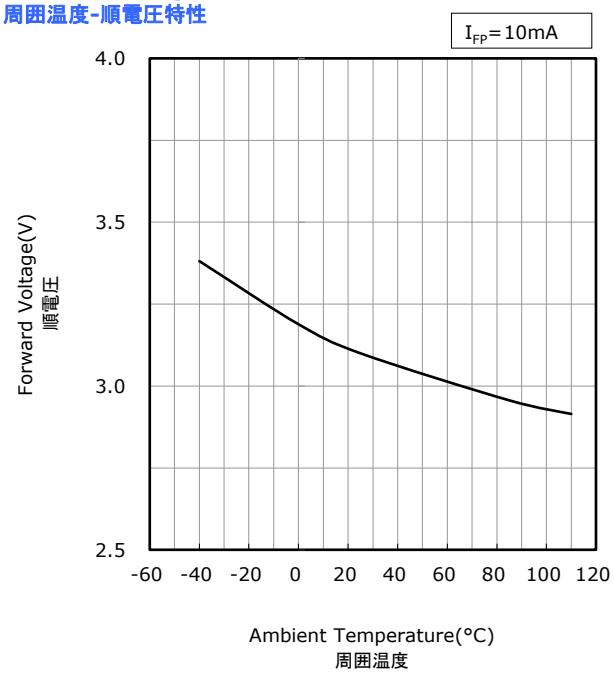
＊ All characteristics shown are for reference only and are not guaranteed.
本特性は参考です。

Part No. NHSR146A
No. STS-DA7-17215

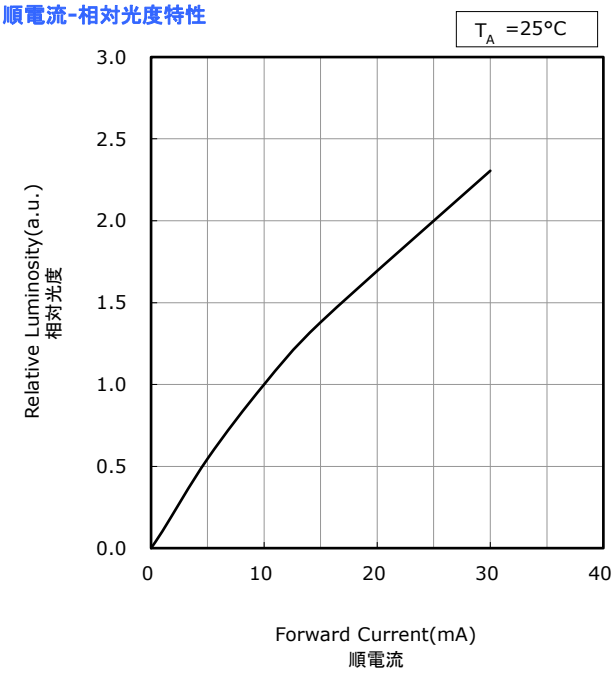
Forward Voltage vs Forward Current
順電圧-順電流特性



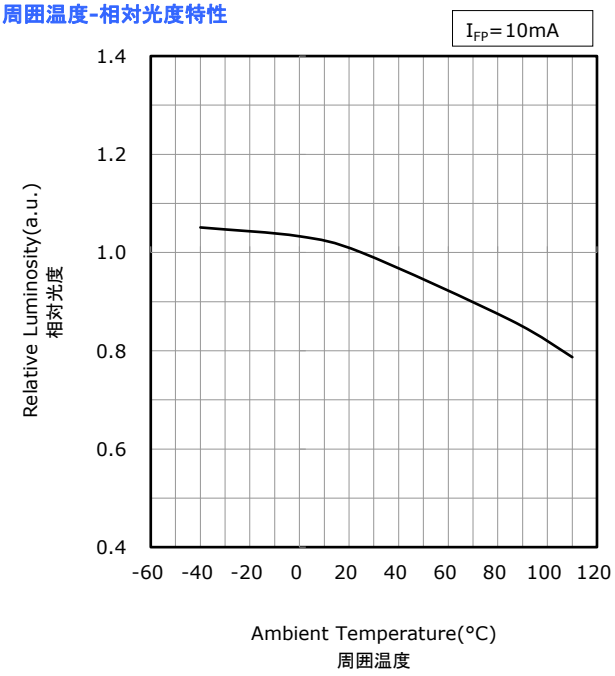
Ambient Temperature vs Forward Voltage
周囲温度-順電圧特性



Forward Current vs Relative Luminosity
順電流-相対光度特性



Ambient Temperature vs Relative Luminosity
周囲温度-相対光度特性



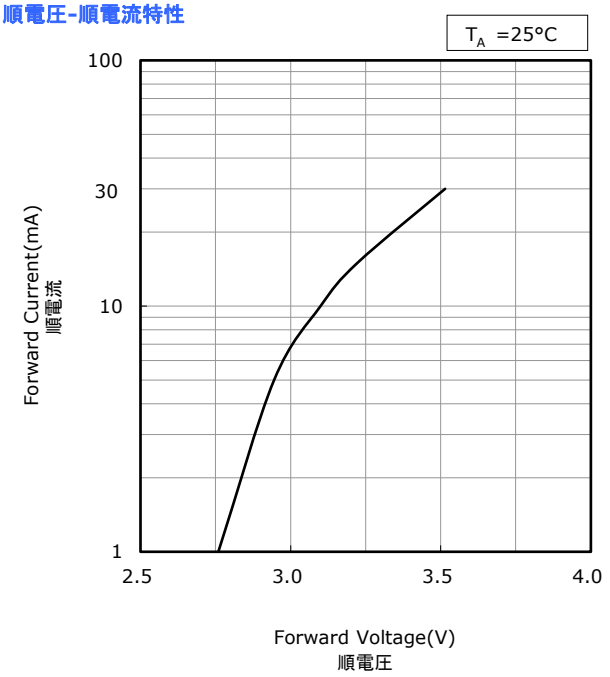
＊ The graphs above show the characteristics for R15z LEDs, including sub-bins, of this product.
本特性は色度ランクR15z(ランク座標範囲内の特別ランクを含む)に対応しています。

FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

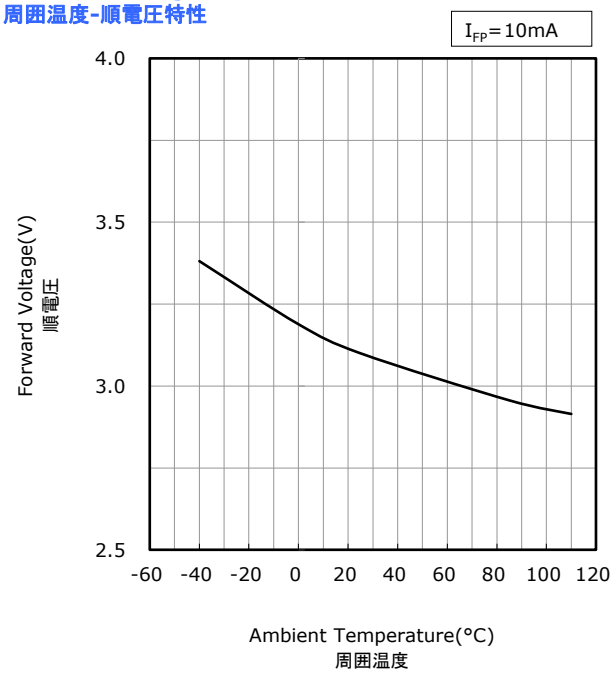
＊ All characteristics shown are for reference only and are not guaranteed.
本特性は参考です。

Part No. NHSR146A
No. STS-DA7-17216

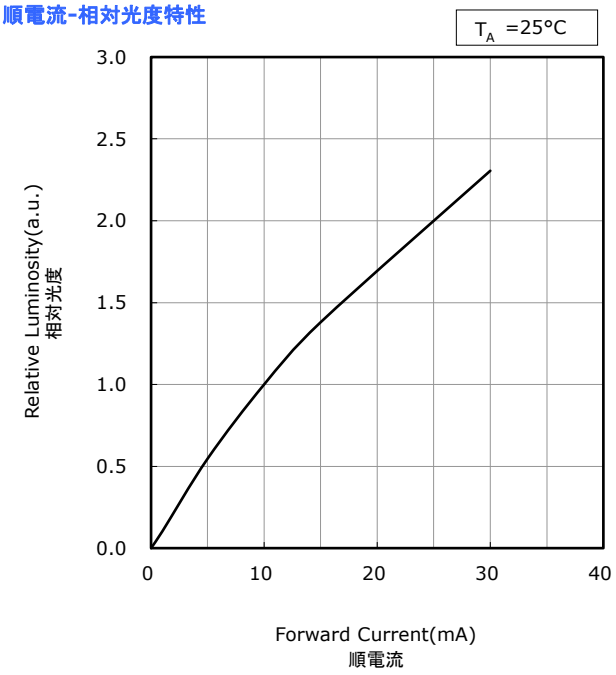
Forward Voltage vs Forward Current
順電圧-順電流特性



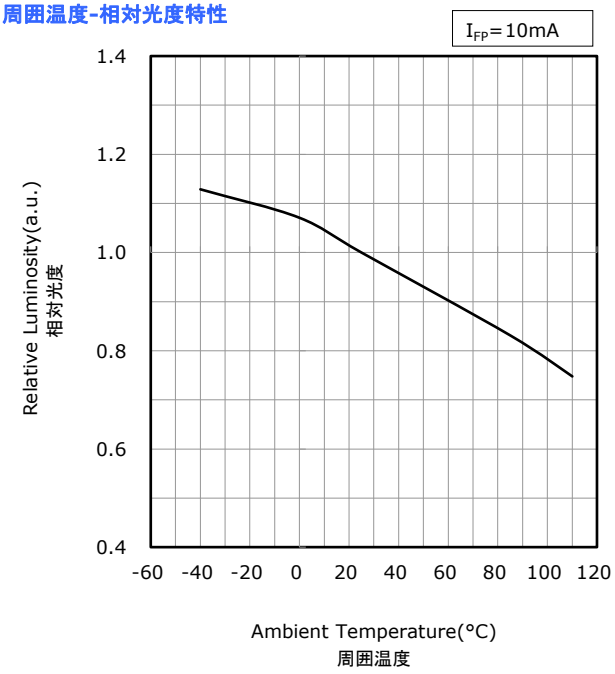
Ambient Temperature vs Forward Voltage
周囲温度-順電圧特性



Forward Current vs Relative Luminosity
順電流-相対光度特性



Ambient Temperature vs Relative Luminosity
周囲温度-相対光度特性



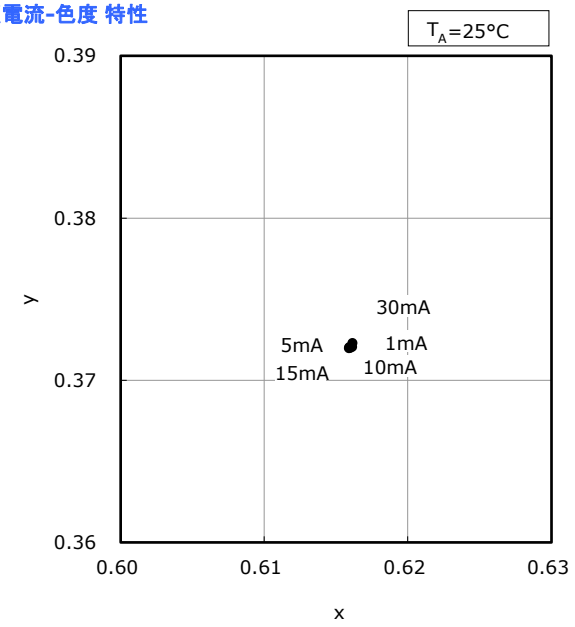
＊ The graphs above show the characteristics for R16z LEDs, including sub-bins, of this product.
本特性は色度ランクR16z(ランク座標範囲内の特別ランクを含む)に対応しています。

FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

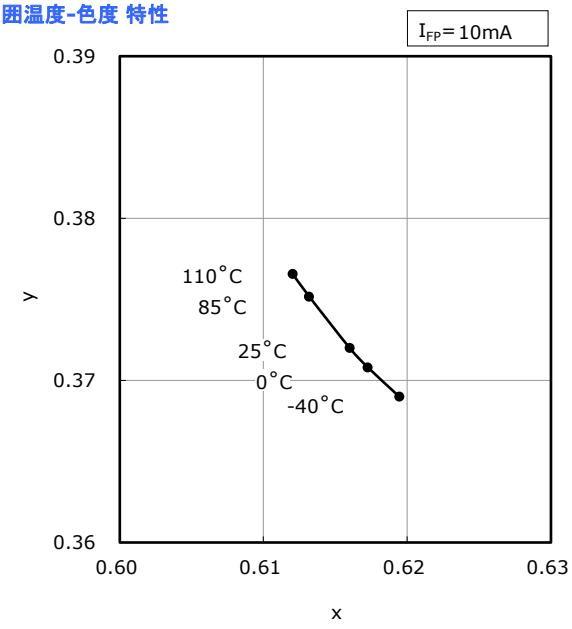
* All characteristics shown are for reference only and are not guaranteed.
本特性は参考です。

Part No. NHSR146A
No. STS-DA7-17217

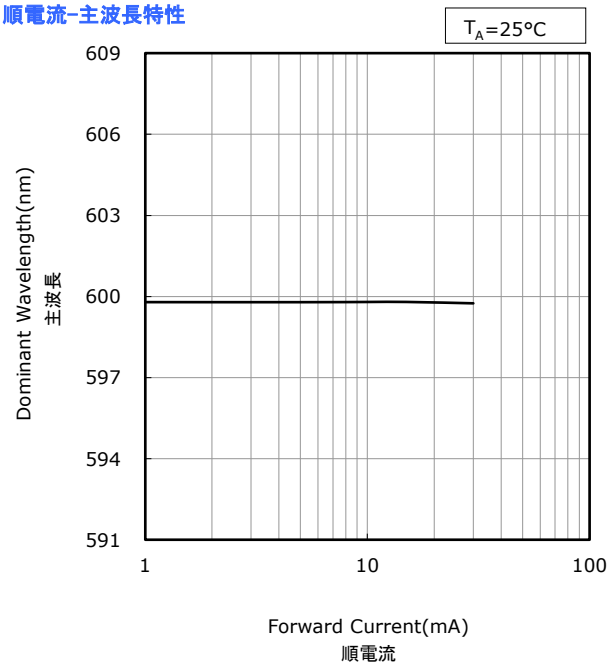
Forward Current vs Chromaticity Coordinate
順電流-色度 特性



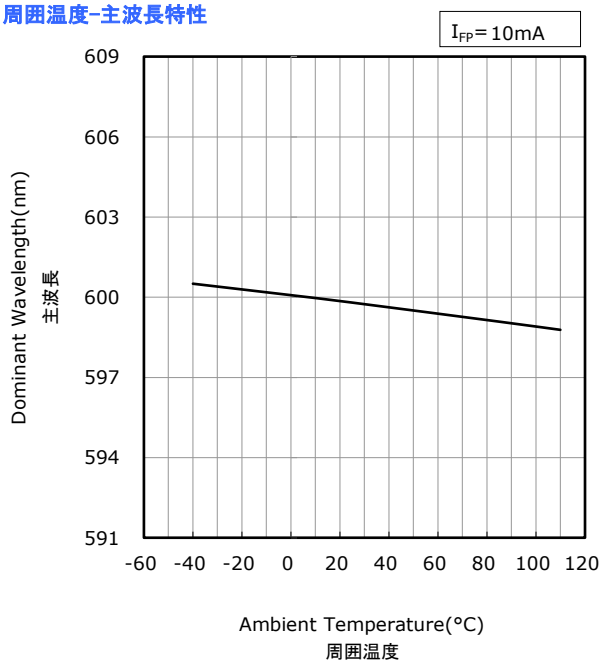
Ambient Temperature vs Chromaticity Coordinate
周囲温度-色度 特性



Forward Current vs Dominant Wavelength
順電流-主波長特性



Ambient Temperature vs Dominant Wavelength
周囲温度-主波長特性



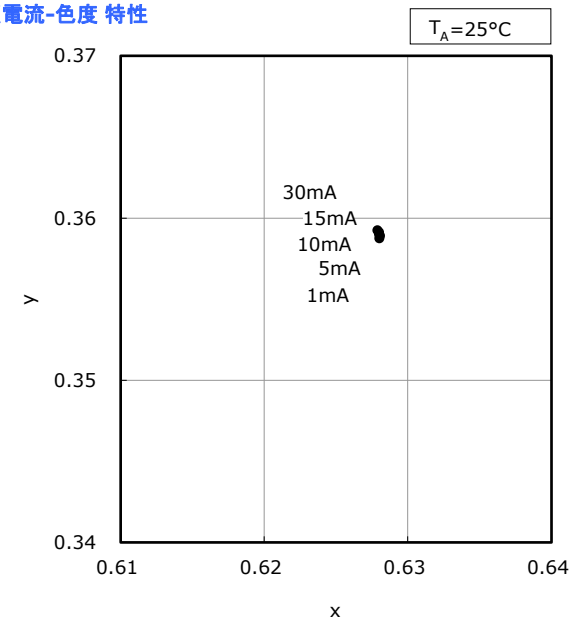
* The graphs above show the characteristics for Or5z LEDs, including sub-bins, of this product.
本特性は色度ランクOr5z(ランク座標範囲内の特別ランクを含む)に対応しています。

FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

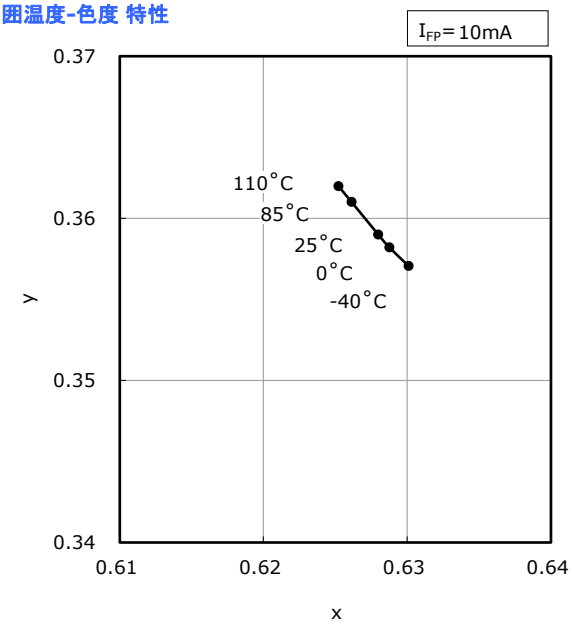
* All characteristics shown are for reference only and are not guaranteed.
本特性は参考です。

Part No. NHSR146A
No. STS-DA7-17218

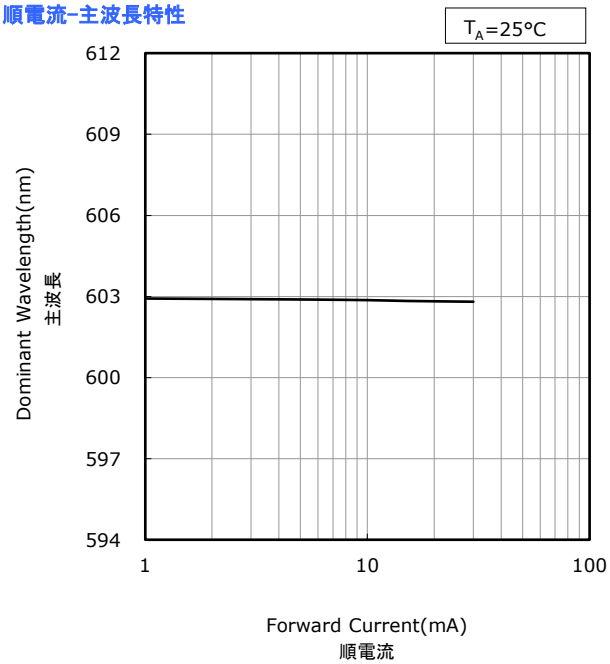
Forward Current vs Chromaticity Coordinate
順電流-色度 特性



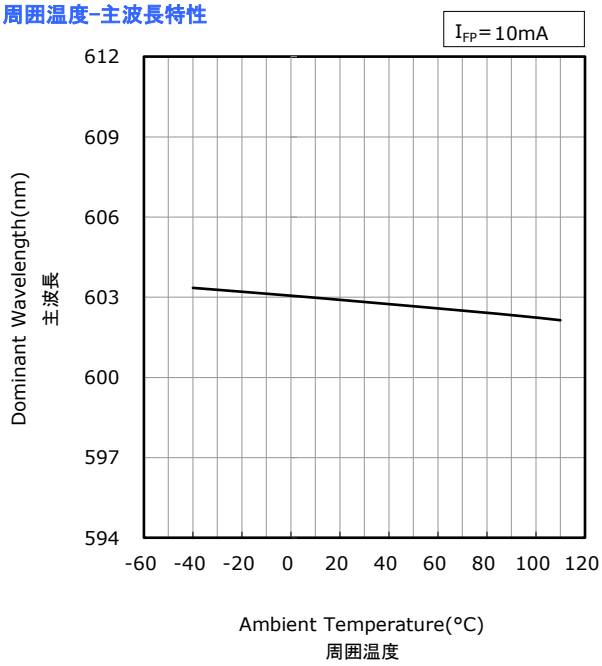
Ambient Temperature vs Chromaticity Coordinate
周囲温度-色度 特性



Forward Current vs Dominant Wavelength
順電流-主波長特性



Ambient Temperature vs Dominant Wavelength
周囲温度-主波長特性



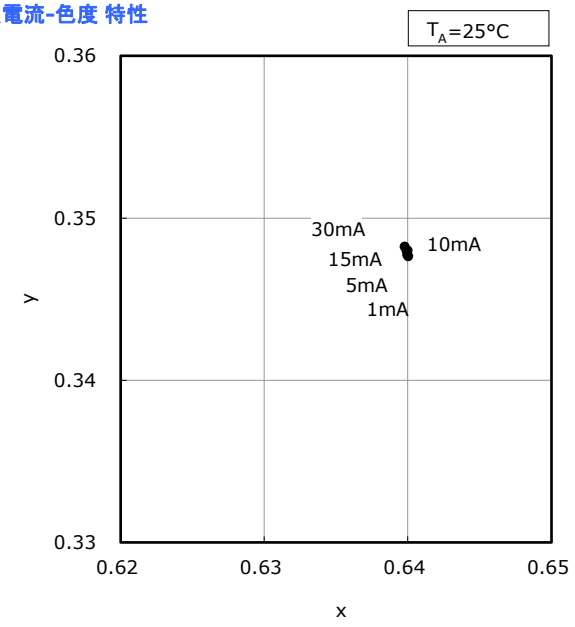
* The graphs above show the characteristics for Or6z LEDs, including sub-bins, of this product.
本特性は色度ランクOr6z(ランク座標範囲内の特別ランクを含む)に対応しています。

FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

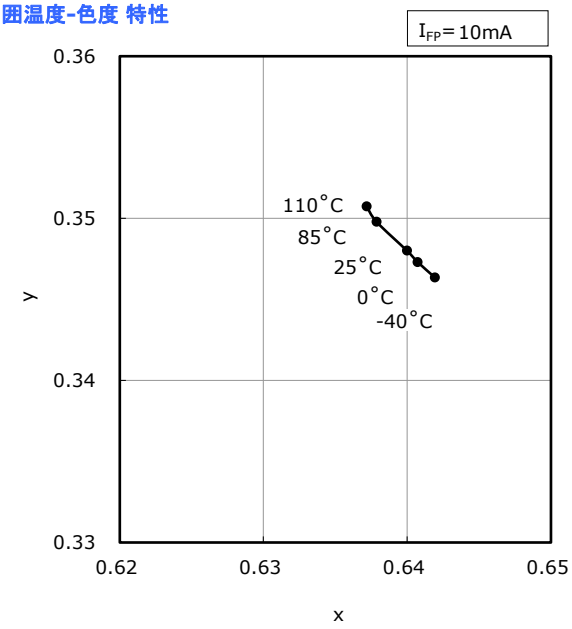
* All characteristics shown are for reference only and are not guaranteed.
本特性は参考です。

Part No. NHSR146A
No. STS-DA7-17219

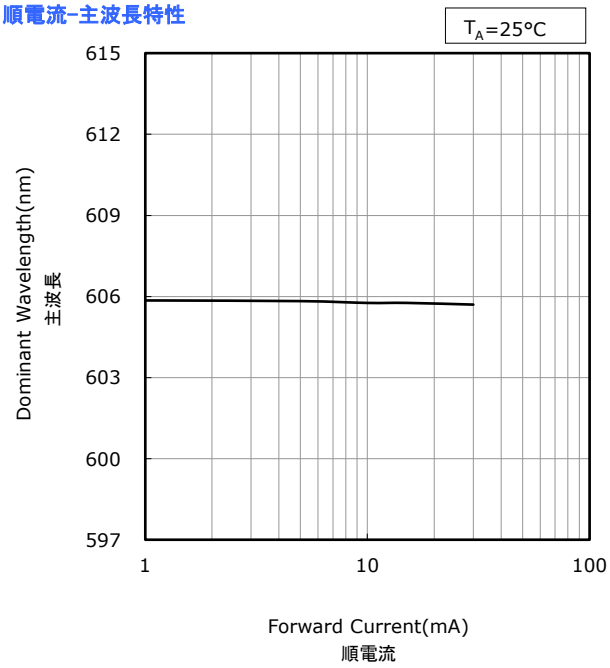
Forward Current vs Chromaticity Coordinate
順電流-色度 特性



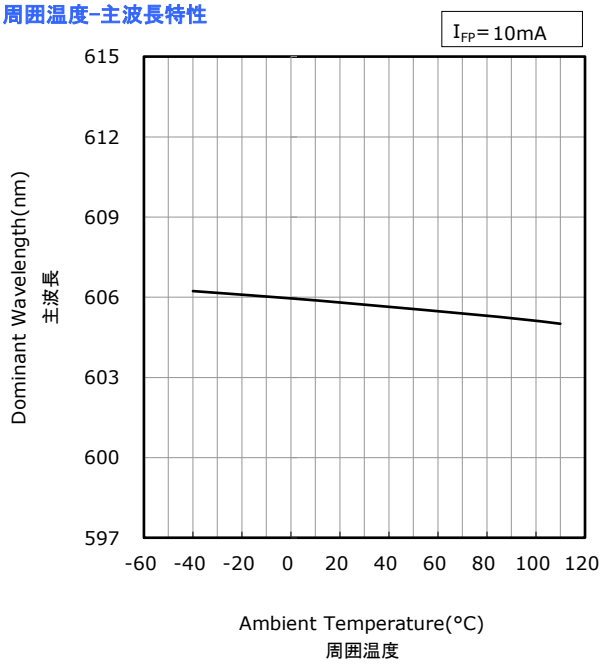
Ambient Temperature vs Chromaticity Coordinate
周囲温度-色度 特性



Forward Current vs Dominant Wavelength
順電流-主波長特性



Ambient Temperature vs Dominant Wavelength
周囲温度-主波長特性



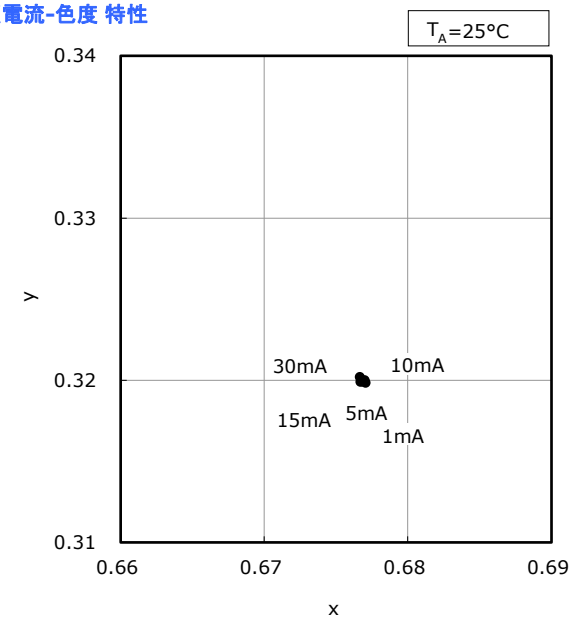
* The graphs above show the characteristics for Or7z LEDs, including sub-bins, of this product.
本特性は色度ランクOr7z(ランク座標範囲内の特別ランクを含む)に対応しています。

FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

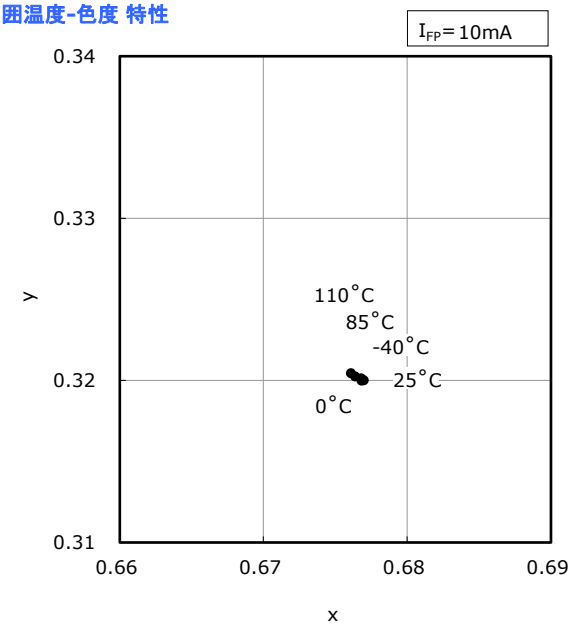
* All characteristics shown are for reference only and are not guaranteed.
本特性は参考です。

Part No. NHSR146A
No. STS-DA7-17220

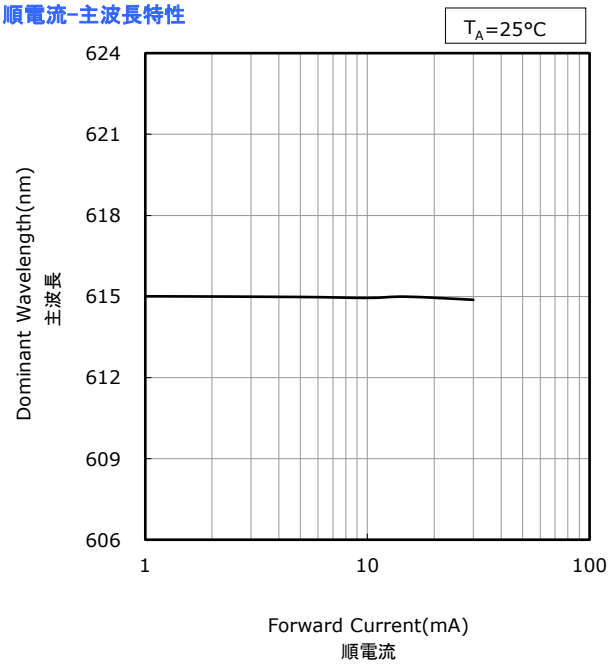
Forward Current vs Chromaticity Coordinate
順電流-色度 特性



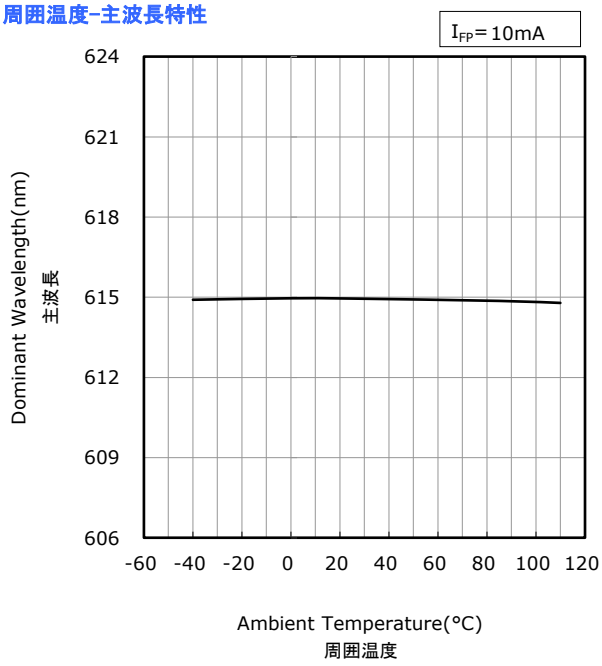
Ambient Temperature vs Chromaticity Coordinate
周囲温度-色度 特性



Forward Current vs Dominant Wavelength
順電流-主波長特性



Ambient Temperature vs Dominant Wavelength
周囲温度-主波長特性



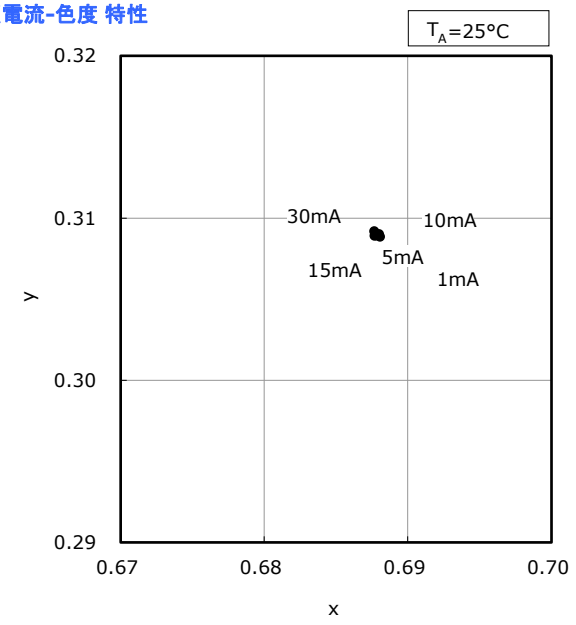
* The graphs above show the characteristics for R13z LEDs, including sub-bins, of this product.
本特性は色度ランクR13z(ランク座標範囲内の特別ランクを含む)に対応しています。

FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

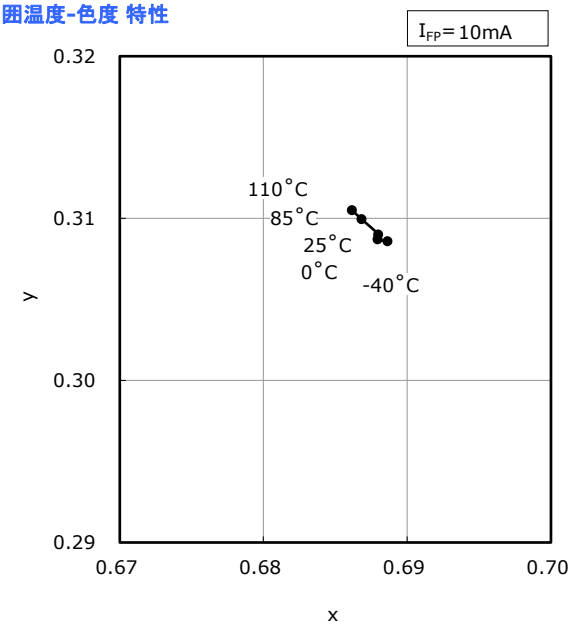
* All characteristics shown are for reference only and are not guaranteed.
本特性は参考です。

Part No. NHSR146A
No. STS-DA7-17221

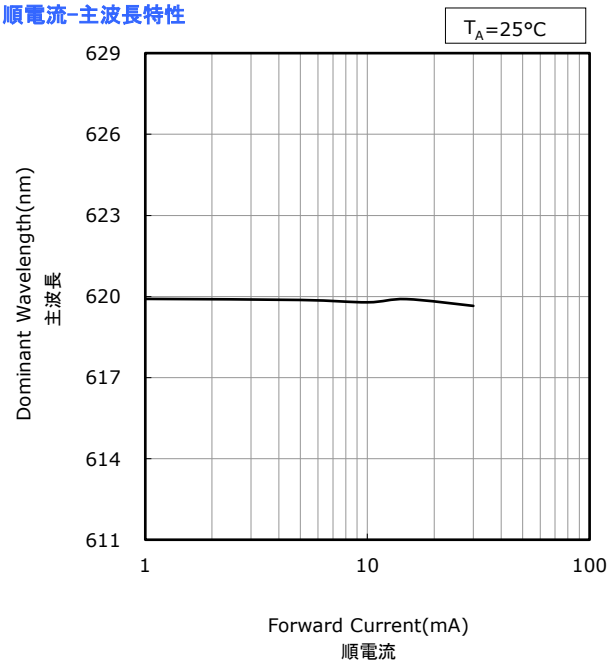
Forward Current vs Chromaticity Coordinate
順電流-色度 特性



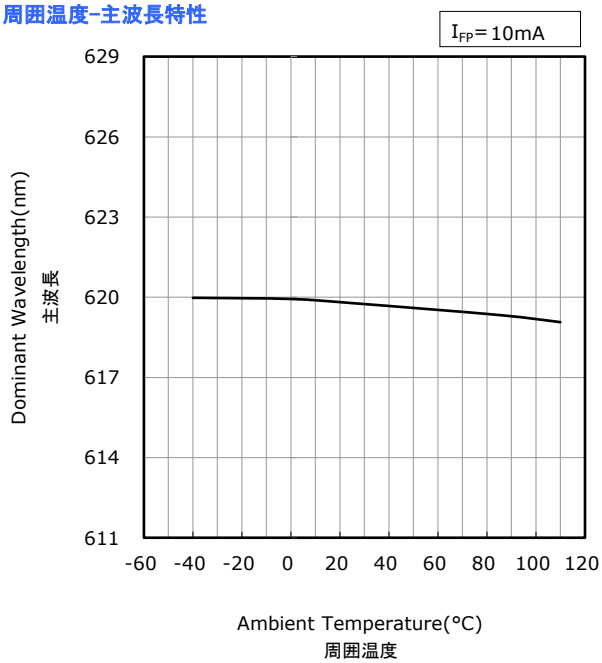
Ambient Temperature vs Chromaticity Coordinate
周囲温度-色度 特性



Forward Current vs Dominant Wavelength
順電流-主波長特性



Ambient Temperature vs Dominant Wavelength
周囲温度-主波長特性



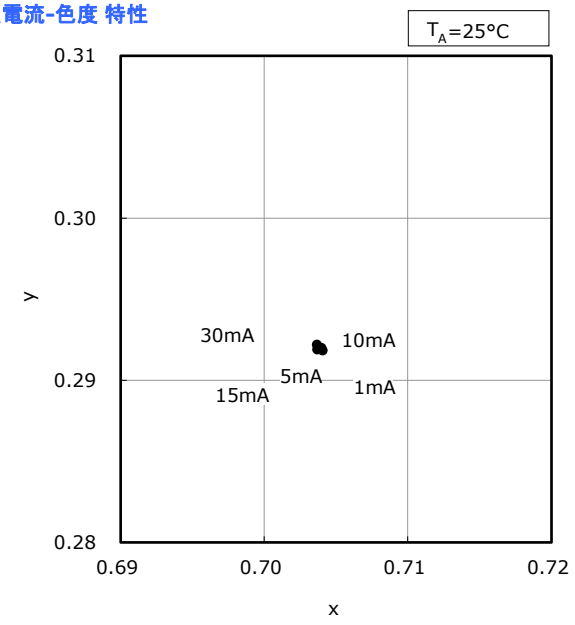
* The graphs above show the characteristics for R14z LEDs, including sub-bins, of this product.
本特性は色度ランクR14z(ランク座標範囲内の特別ランクを含む)に対応しています。

FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

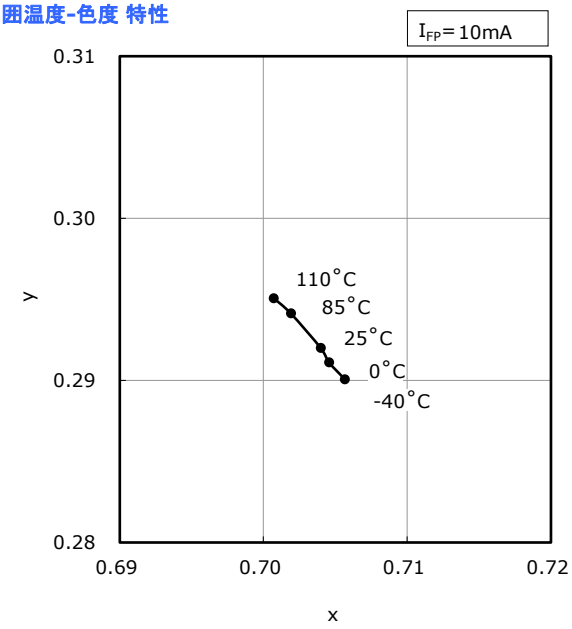
* All characteristics shown are for reference only and are not guaranteed.
本特性は参考です。

Part No. NHSR146A
No. STS-DA7-17222

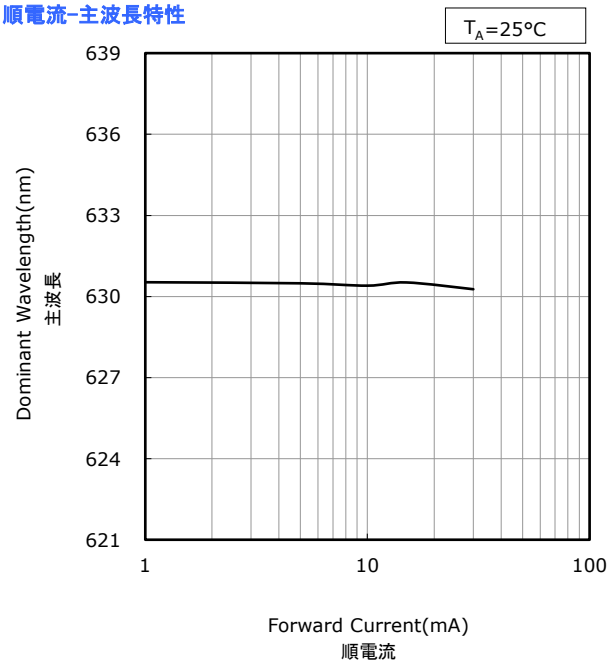
Forward Current vs Chromaticity Coordinate
順電流-色度 特性



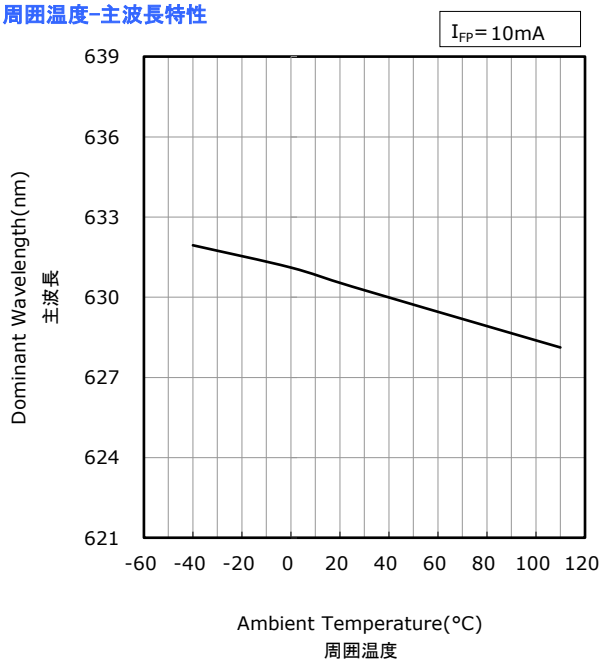
Ambient Temperature vs Chromaticity Coordinate
周囲温度-色度 特性



Forward Current vs Dominant Wavelength
順電流-主波長特性



Ambient Temperature vs Dominant Wavelength
周囲温度-主波長特性



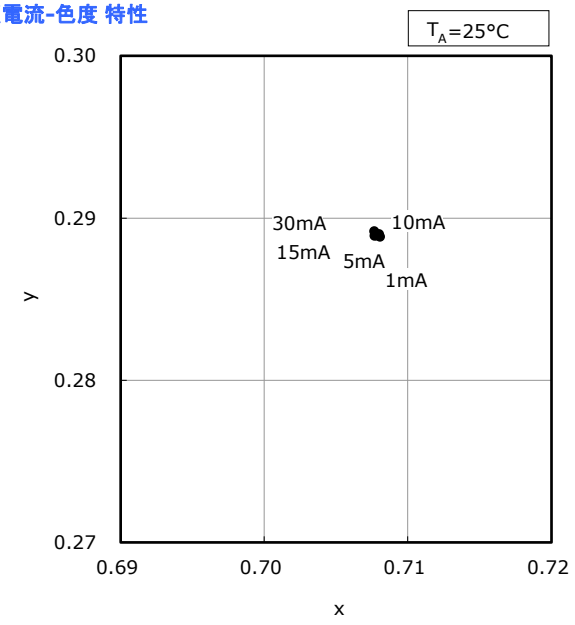
* The graphs above show the characteristics for R15z LEDs, including sub-bins, of this product.
本特性は色度ランクR15z(ランク座標範囲内の特別ランクを含む)に対応しています。

FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

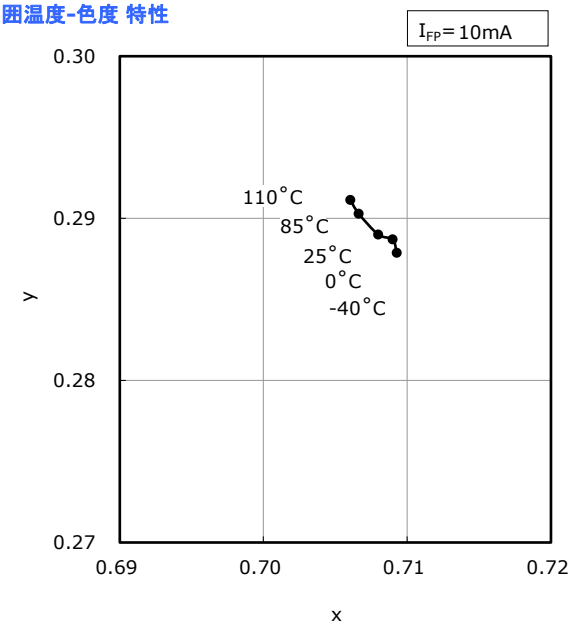
＊ All characteristics shown are for reference only and are not guaranteed.
本特性は参考です。

Part No. NHSR146A
No. STS-DA7-17223

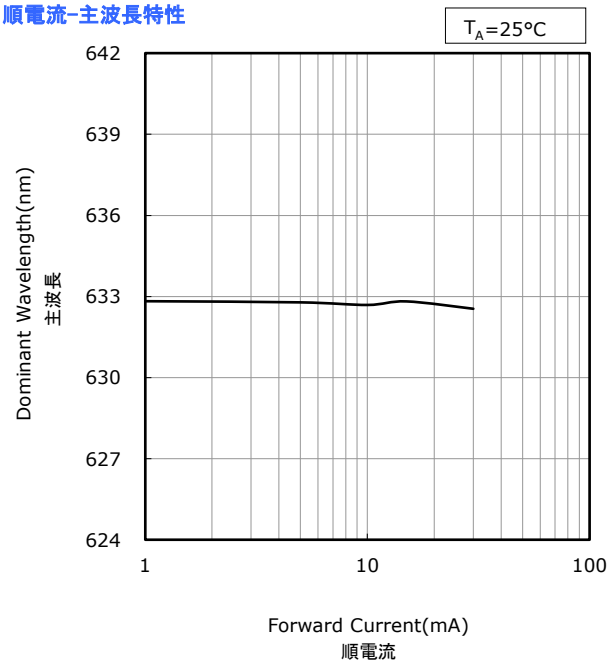
Forward Current vs Chromaticity Coordinate
順電流-色度 特性



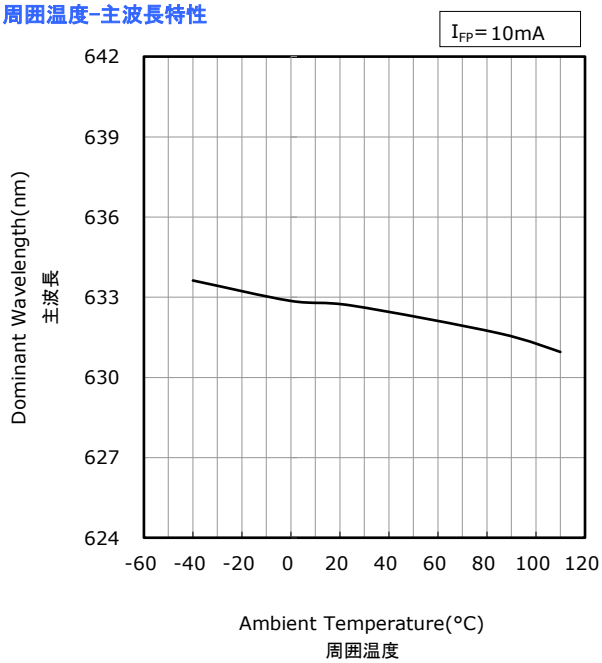
Ambient Temperature vs Chromaticity Coordinate
周囲温度-色度 特性



Forward Current vs Dominant Wavelength
順電流-主波長特性



Ambient Temperature vs Dominant Wavelength
周囲温度-主波長特性



＊ The graphs above show the characteristics for R16z LEDs, including sub-bins, of this product.
本特性は色度ランクR16z(ランク座標範囲内の特別ランクを含む)に対応しています。

RELIABILITY

(1) Tests and Results

Test	Reference Standard	Test Conditions	Test Duration	Failure Criteria #	Units Failed/Tested
Resistance to Soldering Heat (Reflow Soldering)	JEITA ED-4701 300 301	T_{sld}=260°C, 10sec, 2reflows		#1	0/22
Solderability	JEITA ED-4701 303 303A	T_{sld}=245±5°C, 5sec, Lead-free Solder(Sn-3.0Ag-0.5Cu)		#3	0/22
Thermal Shock(Air to Air)		-40°C to 110°C, 15min dwell	100cycles	#1	0/22
Moisture Resistance (Cyclic)	JEITA ED-4701 200 203	25°C~65°C~-10°C, 90%RH, 24hr per cycle	10cycles	#1	0/22
High Temperature Storage	JEITA ED-4701 200 201	T_A=110°C	1000hours	#1	0/22
Temperature Humidity Storage	JEITA ED-4701 100 103	T_A=60°C, RH=90%	1000hours	#1	0/22
Low Temperature Storage	JEITA ED-4701 200 202	T_A=-40°C	1000hours	#1	0/22
Room Temperature Operating Life		T_A=25°C, I_F=15mA Test board: See NOTES below	1000hours	#2	0/22
High Temperature Operating Life		T_A=85°C, I_F=15mA Test board: See NOTES below	1000hours	#2	0/22
Temperature Humidity Operating Life		60°C, RH=90%, I_F=10mA Test board: See NOTES below	1000hours	#2	0/22
Low Temperature Operating Life		T_A=-40°C, I_F=10mA Test board: See NOTES below	1000hours	#2	0/22
Electrostatic Discharges	ANSI/ESDA/ JEDEC JS-001	HBM, 8kV, 1.5kΩ, 100pF, 1pulse, alternately positive or negative		#1	0/22

NOTES:

1) Test board: FR4 board thickness=1.6mm, copper layer thickness=35μm, $R_{\theta JA}$≈455°C/W

2) Measurements are performed after allowing the LEDs to return to room temperature.

(2) Failure Criteria

Criteria #	Items	Conditions	Failure Criteria
#1	Forward Voltage(V_F)	I_F=10mA	>U.S.L.×1.1
	Luminous Intensity(I_v)	I_F=10mA	<L.S.L.×0.7
#2	Forward Voltage(V_F)	I_F=10mA	>U.S.L.×1.1
	Luminous Intensity(I_v)	I_F=10mA	<L.S.L.×0.5
#3	Solderability	-	Less than 95% solder coverage

U.S.L. : Upper Specification Limit L.S.L. : Lower Specification Limit

CAUTIONS

(1) Storage

Conditions		Temperature	Humidity	Time
Storage	Before Opening Aluminum Bag	≤30°C	≤90%RH	Within 1 Year from Delivery Date
	After Opening Aluminum Bag	≤30°C	≤70%RH	≤4weeks
Baking		65±5°C	-	≥24hours

- The storage/packaging requirements for this LED are comparable to JEDEC Moisture Sensitivity Level (MSL) 2a or equivalent. Nichia used IPC/JEDEC STD-020 as a reference to rate the MSL of this LED.
- This LED uses a package that could absorb moisture; if the package absorbs moisture and is exposed to heat during soldering, it may cause the moisture to vaporize and the package to expand and the resulting pressure may cause internal delamination. This may cause the optical characteristics to degrade. To minimize moisture absorption in storage/transit, moisture-proof aluminum bags are used for the LEDs with a silica gel packet to absorb any air moisture in the bag. The silica gel beads turn blue to red as they absorb moisture.
- Once the moisture-proof aluminum bag is open, ensure that the LED is soldered to a PCB within the range of the conditions above. To store any remaining unused LEDs, use a hermetically sealed container with silica gel desiccants. Nichia recommends placing them back to the original moisture-proof bag and reseal it.
- If the "After Opening" storage time has been exceeded or any pink silica gel beads are found, ensure that the LED are baked before use. Baking should only be done once.
- The parts/materials (e.g. housing, gasket/seal, secondary lens, lens cover, thermal grease, etc.) used with the LED in the same assembly/system may release corrosive gases containing sulfur, halogens, etc. A light-up test, sufficient verifications, etc. must be performed at the finished product level (i.e. automotive headlamp, luminaire, etc.) prior to use taking into consideration the conditions/environments in which the finished product will actually be used to ensure that the expected performance for the finished product is maintained. See below for the detailed information.

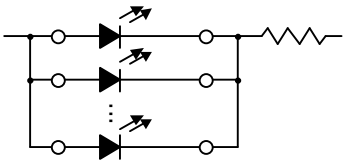
  Issues that may be caused by corrosive gases containing sulfur, halogens, etc.:

  This LED has plated parts. If the LED is exposed to corrosive gases containing sulfur, halogens, etc., it may cause the plated surface to tarnish. If the gases penetrate the LED (e.g. emitting surface, package material, etc.), it may cause the surface of the plated parts inside the package to tarnish. In addition, it has been confirmed that if a silicone resin is used in the LED, the gases may accelerate degradation of the silicone resin. As a result, the optical characteristics may be adversely affected (i.e. significant reduction in the brightness, significant color shift, etc.); in the worst case, the circuit could become open causing a catastrophic failure (i.e. the LED not to illuminate). When determining the storage environment for the LED and/or selecting parts/materials that will be used with the LED in the finished product, it must be ensured prior to use that corrosive gases containing sulfur, halogens, etc. are not generated.
- To avoid condensation, the LEDs must not be stored in areas where temperature and humidity fluctuate greatly.
- Do not store the LEDs in a dusty environment.
- Do not expose the LEDs to direct sunlight and/or an environment over a long period of time where the temperature is higher than normal room temperature.

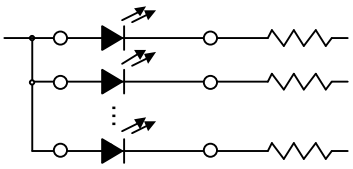
(2) Directions for Use

- The circuit must be designed to ensure that the Absolute Maximum Ratings are not exceeded for each LED. The LEDs should be operated at a constant current per LED. In the case of operating at a constant voltage, Circuit B is recommended. If Circuit A is used, it may cause the currents flowing through the LEDs to vary due to the variation in the forward voltage characteristics of the LEDs on the circuit.

(A)



(B)



- This LED is designed to be operated at a forward current. Ensure that no voltage is applied to the LED in the forward/reverse direction while the LED is off. If the LEDs are used in an environment where reverse voltages are applied to the LED continuously, it may cause electrochemical migration to occur causing the LED to be damaged. When not in use for a long period of time, the system's power should be turned off to ensure that there are no issues/damage.
- To stabilize the LED characteristics while in use, Nichia recommends that the LEDs are operated at currents ≥ 10% of the sorting current.
- Ensure that transient excessive voltages (e.g. lightning surge) are not applied to the LEDs.
- If the LEDs are used for outdoor applications, ensure that necessary measures are taken (e.g. protecting the LEDs from water/salt damage and high humidity).

(3) Handling Precautions

- Do not handle the LEDs with bare hands as it will contaminate the LED surface and may affect the optical characteristics: it might cause the LED to be deformed and/or the wire to break, which will cause the LED not to illuminate. The lead could also cause an injury.
- Ensure that when handling the LEDs with tweezers, excessive force is not applied to the LED. Otherwise, it may cause damage to the resin (e.g. cut, scratch, chip, crack, delamination and deformation) and the wire to break causing a catastrophic failure (i.e. the LED not to illuminate).
- Dropping may cause damage to the LED (e.g. deformation).
- Do not stack assembled PCBs together. Otherwise, it may cause damage to the resin (e.g. cut, scratch, chip, crack, delamination and deformation) and the wire to break causing a catastrophic failure (i.e. the LED not to illuminate).

(4) Design Consideration

- If the LEDs are soldered to a PCB and the PCB assembly is bent (e.g. PCB depaneling process), it may cause the LED package to break. The PCB layout should be designed to minimize the mechanical stress on the LEDs when the PCB assembly is bent/warped.
- The amount of mechanical stress exerted on the LED from depaneling may vary depending on the LED position/orientation on the PCB assembly (e.g. especially in areas near V-groove scores). The PCB layout should be designed to minimize the mechanical stress on the LEDs when the PCB is separated into individual PCB assemblies.
- To separate a PCB populated with the LEDs, use a specially designed tool. Do not break the PCB by hand.
- The parts/materials (e.g. housing, gasket/seal, secondary lens, lens cover, thermal grease, etc.) used with the LED in the same assembly/system may release corrosive gases containing sulfur, halogens, etc., and/or volatile organic compounds (VOCs). A light-up test, sufficient verifications, etc. must be performed at the finished product level (i.e. automotive headlamp, luminaire, etc.) prior to use taking into consideration the conditions/environments in which the finished product will actually be used to ensure that the expected performance for the finished product is maintained. See below for the detailed information.

  Issues that may be caused by corrosive gases containing sulfur, halogens, etc.:

  This LED has plated parts. If the LED is exposed to corrosive gases containing sulfur, halogens, etc., it may cause the plated surface to tarnish. If the gases penetrate the LED (e.g. emitting surface, package material, etc.), it may cause the surface of the plated parts inside the package to tarnish. In addition, it has been confirmed that if a silicone resin is used in the LED, the gases may accelerate degradation of the silicone resin. As a result, the optical characteristics may be adversely affected (i.e. significant reduction in the brightness, significant color shift, etc.); in the worst case, the circuit could become open causing a catastrophic failure (i.e. the LED not to illuminate). When determining the storage environment for the LED and/or selecting parts/materials that will be used with the LED in the finished product, it must be ensured prior to use that corrosive gases containing sulfur, halogens, etc. are not generated.

  Issues that may be caused by VOCs:

  If VOCs that have been released from the parts/materials and/or organic additives used with the LED in the finished product penetrate into the LED and remain inside the LED, the VOCs can discolor after being exposed to heat and/or photon energy. This may cause the optical characteristics to be adversely affected (i.e. significant reduction in the brightness, significant color shift, etc.). This adverse effect may be improved by ventilating the environment (i.e. the LED is not used in a hermetically sealed environment) to prevent the VOCs from remaining inside the LED. When selecting parts/materials that will be used with the LED in the finished product, it must be ensured prior to use that there are no issues with the substances found in those parts/materials and/or that the expected performance for the finished product is maintained by performing a light-up test, sufficient verifications etc. taking into consideration the conditions/environments in which the finished product will actually be used.

(5) Electrostatic Discharge (ESD)

- This LED is sensitive to transient excessive voltages (e.g. ESD, lightning surge). If this excessive voltage occurs in the circuit, it may cause the LED to be damaged causing issues (e.g. the LED to become dimmer or not to illuminate [i.e. catastrophic failure]). Ensure that when handling the LEDs, necessary measures are taken to protect them from an ESD discharge. The following examples are recommended measures to eliminate the charge:
  - Grounded wrist strap, ESD footwear, clothes, and floors
  - Grounded workstation equipment and tools
  - ESD table/shelf mat made of conductive materials
- Ensure that all necessary measures are taken to prevent the LEDs from being exposed to transient excessive voltages (e.g. ESD, lightning surge):
  - tools (e.g. soldering irons), jigs, and machines that are used are properly grounded
  - appropriate ESD materials/equipment are used in the work area
  - the system/assembly is designed to provide ESD protection for the LEDs.
- If the tool/equipment used is an insulator (e.g. glass cover, plastic, etc.), ensure that necessary measures have been taken to protect the LED from transient excessive voltages (e.g. ESD). The following examples are recommended measures to eliminate the charge:
  - Dissipating static charge with conductive materials
  - Preventing charge generation with moisture
  - Neutralizing the charge with ionizers
- To detect if an LED was damaged by transient excess voltages (i.e. an ESD event during the system's assembly process), perform a characteristics inspection (e.g. forward voltage measurement, light-up test) at low current (≤1mA).
- Failure Criteria: V_F<2.0V at I_F=0.5mA
  If the LED is damaged by transient excess voltages (e.g. ESD), it will cause:
  - the Forward Voltage (V_F) to decrease
  - the LED not to illuminate at a low current

(6) Thermal Management

- The Absolute Maximum Junction Temperature (T_J) must not be exceeded under any circumstances. The increase in the temperature of an LED while in operation may vary depending on the PCB thermal resistance and the density of LEDs on the PCB assembly. Ensure that when using the LEDs for the chosen application, heat is not concentrated in an area and properly managed in the system/assembly.
- The operating current should be determined by considering the temperature conditions surrounding the LED (i.e. T_A). Ensure that when operating the LED, proper measures are taken to dissipate the heat.

(7) Cleaning

- Do not clean the LEDs with water, benzine and/or thinner.
- To clean the LEDs, use isopropyl alcohol (IPA). If another solvent is used, it may cause the LED package/resin to be damaged causing issues; ensure that sufficient verification is performed prior to use. Additionally, ensure that the solvent being used does not cause any other issues (e.g. CFC-based solvents are heavily regulated).
- If an LED is contaminated (e.g. dust/dirt), use a cloth soaked with isopropyl alcohol (IPA). Ensure that the cloth is firmly squeezed before wiping the LED.
- Do not clean the LEDs with an ultrasonic cleaner. If cleaning must be done, ensure that sufficient verification is performed by using a finished assembly with LEDs to determine cleaning conditions (e.g. ultrasonic power, LED position on the PCB assembly) that do not cause an issue.

(8) Eye Safety

- There may be two important international specifications that should be noted for safe use of the LEDs: IEC 62471:2006 Photobiological safety of lamps and lamp systems and IEC 60825-1:2001 (i.e. Edition 1.2) Safety of Laser Products - Part 1: Equipment Classification and Requirements. Ensure that when using the LEDs, there are no issues with the following points:
  - LEDs have been removed from the scope of IEC 60825-1 since IEC 60825-1:2007 (i.e. Edition 2.0) was published. However, depending on the country/region, there are cases where the requirements of the IEC 60825-1:2001 specifications or equivalent must be adhered to.
  - LEDs have been included in the scope of IEC 62471:2006 since the release of the specification in 2006.
  - Most Nichia LEDs will be classified as the Exempt Group or Risk Group 1 according to IEC 62471:2006. However, in the case of high-power LEDs containing blue wavelengths in the emission spectrum, there are LEDs that will be classified as Risk Group 2 depending on the characteristics (e.g. radiation flux, emission spectrum, directivity, etc.)
  - If the LED is used in a manner that produces an increased output or with an optic to collimate the light from the LED, it may cause damage to the human eye.
- If an LED is operated in a manner that emits a flashing light, it may cause health issues (e.g. visual stimuli causing eye discomfort). The system should be designed to ensure that there are no harmful effects on the human body.

(9) Miscellaneous

- Nichia warrants that the discrete LEDs will meet the requirements/criteria as detailed in the Reliability section within this specification. If the LEDs are used under conditions/environments deviating from or inconsistent with those described in this specification, the resulting damage and/or injuries will not be covered by this warranty.
- Nichia warrants that the discrete LEDs manufactured and/or supplied by Nichia will meet the requirements/criteria as detailed in the Reliability section within this specification; it is the customer's responsibility to perform sufficient verification prior to use to ensure that the lifetime and other quality characteristics required for the intended use are met.
- The applicable warranty period is one year from the date that the LED is delivered. In the case of any incident that appears to be in breach of this warranty, the local Nichia sales representative should be notified to discuss instructions on how to proceed while ensuring that the LED in question is not disassembled or removed from the PCB if it has been attached to the PCB. If a breach of this warranty is proved, Nichia will provide the replacement for the non-conforming LED or an equivalent item at Nichia's discretion. FOREGOING ARE THE EXCLUSIVE REMEDIES AVAILABLE TO THE CUSTOMER IN RESPECT OF THE BREACH OF THE WARRANTY CONTAINED HEREIN, AND IN NO EVENT SHALL NICHIA BE RESPONSIBLE FOR ANY INDRECT, INCIDENTAL OR CONSEQUENTIAL LOSSES AND/OR EXPENSES (INCLUDING LOSS OF PROFIT) THAT MAY BE SUFFERED BY THE CUSTOMER ARISING OUT OF A BREACH OF THE WARRANTY.
- NICHIA DISCLAIMS ALL OTHER WARRANTIES, EXPRESS OR IMPLIED, INCLUDING THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE.
- This LED is intended to be used for general lighting, household appliances, electronic devices (e.g. mobile communication devices) and automobiles; it is not designed or manufactured for use in applications that require safety critical functions (e.g. aircraft, combustion equipment, life support systems, nuclear reactor control system, safety devices, spacecraft, submarine repeaters, traffic control equipment, trains, vessels, etc.). If the LEDs are planned to be used for these applications, unless otherwise detailed in the specification, Nichia will neither guarantee that the LED is fit for that purpose nor be responsible for any resulting property damage, injuries and/or loss of life/health.
- The customer will not reverse engineer, disassemble or otherwise attempt to extract knowledge/design information from the LED.
- All copyrights and other intellectual property rights in this specification in any form are reserved by Nichia or the right holders who have granted Nichia permission to use the content. Without prior written permission from Nichia, no part of this specification may be reproduced in any form or by any means.
- Both the customer and Nichia will agree on the official specifications for the supplied LEDs before any programs are officially launched. Without this agreement in writing (i.e. Customer Specific Specification), changes to the content of this specification may occur without notice (e.g. changes to the foregoing specifications and appearance, discontinuation of the LEDs, etc.).